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ADVANCED VERY HIGH RESOLUTION

RADIOMETER, MOD 2

FINAL ENGINEERING REPORT

(NASA-CR-160034) ADVANCED VERY HIGH
RESOLUTION RADIOMETER, MOD 2 ENGINEERING
REPORT Final Report (ITT Aerospace/Optical
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1.0 INTRODUCTION

The Advanced Very High Resolution Radiometer, Mod 2 (AVHRR/2) is a modification of the original AVHRR (AVHRR/1) to expand the number of channels from four to five and provide additional sensing in the infrared region. Figure 1-1 gives a comparison of the spectral regions employed in the two instruments. As seen in this table, three of the channels are the same on both instruments. The difference in instruments is in the long wave IR region where a single channel has been replaced by two channels.

The modification from AVHRR/1 to AVHRR/2 has been done with a minimum of changes. The areas of change are highlighted in Figure 1-2 and the modifications by module are summarized in Figure 1-3. It can be seen that the primary changes are in the relay optics and in the cooler.

In this development program only two models are involved. The first model, the Optical Test Model (OTM) was constructed and tested to prove the performance and structural integrity of the optical system and the modified cooler. The second model constructed is the Protoflight (PFM).

This document will deal only with the areas of the AVHRR/2 which have been modified from the AVHRR/1 design. These are discussed in the sections which follow.

AVHRR + ADDITIONAL THERMAL CHANNEL = AVHRR MOD. 2

<u>CHANNEL</u>	<u>AVHRR/1</u>	<u>AVHRR/2</u>
1	.58 TO .68	No CHANGE
2	.725 TO \approx 1.00	No CHANGE
3	10.5 TO 11.5	10.3 TO 11.3
4	3.55 TO 3.93	No CHANGE
5	NONE	11.5 TO 12.5

FIGURE 1-1

AVHRR/2 MODULES

SCANNER

SAME AS FOR AVHRR/1
BEING PROCURED AS COMMON PART ON AVHRR FLIGHT MODEL PROGRAM

ELECTRONICS

PRESENT AVHRR/1 DESIGNED TO ACCOMMODATE 5 DATA CHANNELS
AVHRR/2 ADDS AMPLIFIERS, TM, AND COMMAND FOR 5TH CHANNEL
ADDED CIRCUITS ARE DUPLICATES OF EXISTING AVHRR/1 DESIGNS.

OPTICS

TELESCOPE - SAME AS AVHRR/1
BEING PROCURED AS COMMON PART ON FM
PROGRAM FROM PERKIN-ELMER

RELAY OPTICS - CH. 1 AND CH. 2 SAME AS AVHRR/1
IR PORTION REDESIGNED TO PROVIDE FOR 3RD
THERMAL CHANNEL.
RELAY OPTICAL ELEMENTS ASSEMBLED BY ITT.

COOLER

SIZE AND THERMAL CONSTRUCTION SAME AS AVHRR/1.
ADDED OPTICAL PORT INCORPORATED TO INTERFACE WITH
NEW IR RELAY OPTICS.

BASEPLATE

ESSENTIALLY THE SAME AS AVHRR/1
MOUNTING INTERFACE WITH COOLER MODIFIED FOR
REVISED COOLER POSITION.

FIGURE 1-3

2.0 OPTICAL DESIGN

A comparison of the AVHRR/2 and AVHRR/1 optics is given in Figure 2-1. The scan mirror, telescope and Channel 1 and 2 relay optics are identical in both instruments. The transparent gold dichroic beamsplitter which reflects the infrared channels and transmits the Channels 1 and 2 is also retained both in function, size and location (just behind the telescope primary mirror). As indicated in Figure 2-2 one more dichroic beamsplitter is added to the five channel design which reflects the mid-IR band (Channel 4) and transmits the two far-IR bands (Channels 3 and 5). The aplanat lens designs used in AVHRR/1 have been retained in AVHRR/2 with the added Channel 5 aplanat lens being the same as Channel 4 except that the AR coating is modified for best transmission in the Channel 5 spectral region. The focus lenses are basically the same in function but radii of curvatures have been adjusted for the use of the Zn Se material in channels 3 and 5 and to reduce the thickness, and hence mass, of the Channel 4 lenses. Zinc selenide was selected for use in Channels 3 and 5 rather than germanium because it has negligible absorption and will provide more uniform spectral response.

Figure 2-3 illustrates the optical configuration of the AVHRR/2. After separation of the mid and far IR bands by dichroic D4, the far IR bands are re-directed by a flat folding mirror M3 in order to get the beam into the radiant cooler. Vacuum housing windows W1 and W3 are used to pressure seal the radiant cooler for bench testing. Windows W2 and W4 are used on the first stage radiator of the cooler for contamination protection of the cold patch and to reduce the radiant heat load on the patch. Channels 3 and 5 are arranged on the cold patch in AVHRR/2 in the same manner as Channels 3 and 4 in AVHRR/1.

Figure 2-4 and 2-5 give the detail design information for the reimaging optics for the infrared channels. In Figure 2-4 the germanium doublet lenses (surfaces 10, 11, 12 and 13) constitutes focus lens L6 in Figure 2-3, the two sapphire flat elements are cooler windows W3 and W4, the germanium flat element is filter F4 and the aplanatic lens (surfaces 20 and 21) is lens L7; the long wave channels have similar correspondence, the two zinc selenide lenses (surfaces 6, 7, 8 and 9) in Figure 2-5 being lens L1 in Figure 2-3, etc. The sensitive areas of the infrared detectors are located at the image plane identified for each channel and therefore serve as the field stops. The edge width of each of the three infrared detectors is $0.0068'' + 0.0003''$ which provides the IFOV (instantaneous field of view) of 1.31 milliradians.

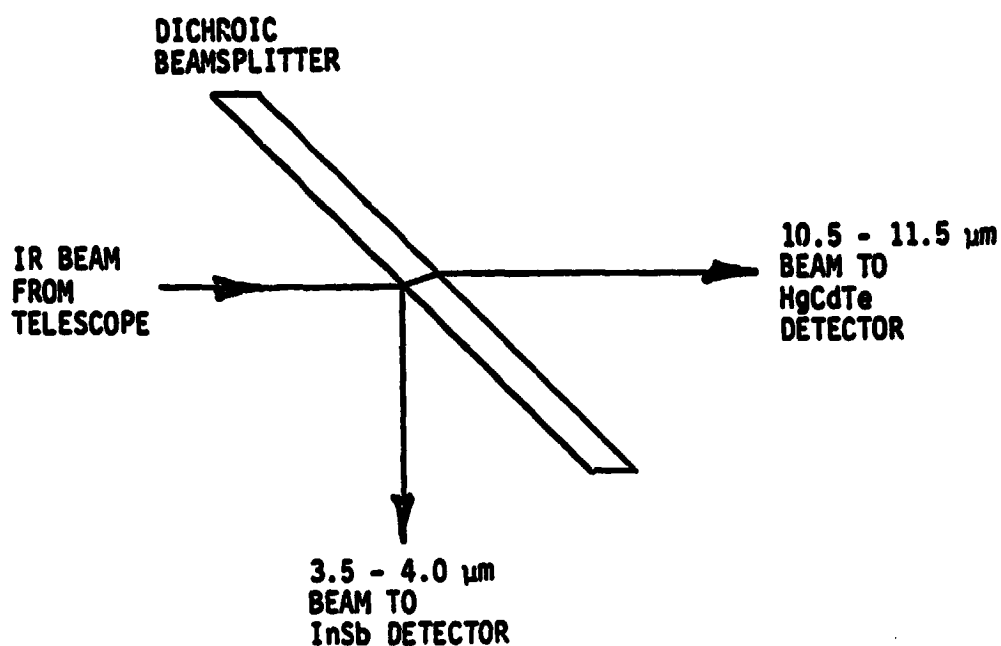
The AVHRR/2 (as well as AVHRR/1) optical system is designed to cover a larger FOV than the required 1.31 m.r. by 1.31 m.r. This larger FOV is called the extended FOV and is illustrated in Figure 2-6. It is designed into the optical system so that the detectors can be displaced from their design nominal positions for purposes of registering the channels without serious optical performance

<u>ITEM</u>	<u>COMPARISON WITH MOD. 1</u>
SCAN MIRROR	SAME
TELESCOPE	SAME
CH. 1 & 2 RELAY OPTICS	SAME
BEAMSPLITTERS	ONE ADDED TO SEPARATE MID-IR BAND FROM TWO FAR-IR BANDS.
APLANAT LENSES	CH. 3 & 4 - SAME; CH. 5 - SAME DESIGN AS MOD 1, CH. 4 (AR COATING THICKNESS ADJUSTED).
FOCUS LENSES	CH. 3 & 5 USE Zn SE INSTEAD OF Ge, RADIUS OF CURVES SLIGHTLY DIFFERENT; CH. 4 - SAME MTL (Ge) BUT THICKNESS REDUCED TO REDUCE WEIGHT OF RELAY OPTICS.

COMPARISON OF MOD. 1 & 2 OPTICS

FIGURE 2- 1

AVHRR/MOD. 1



AVHRR/MOD. 2

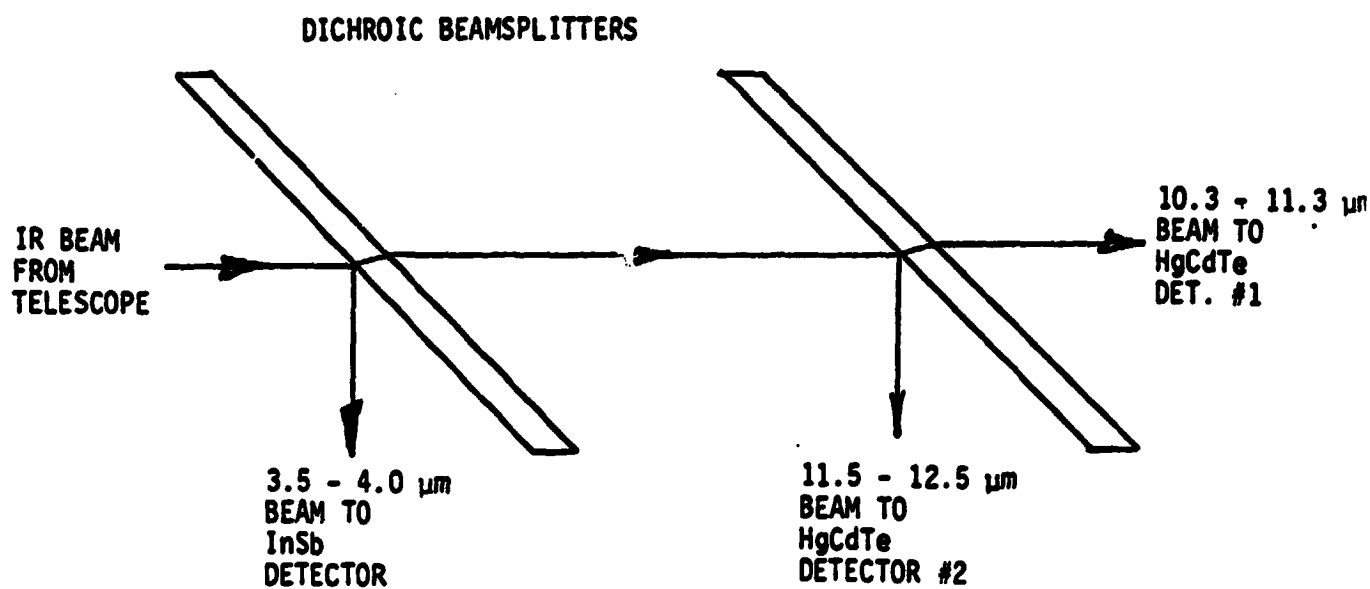
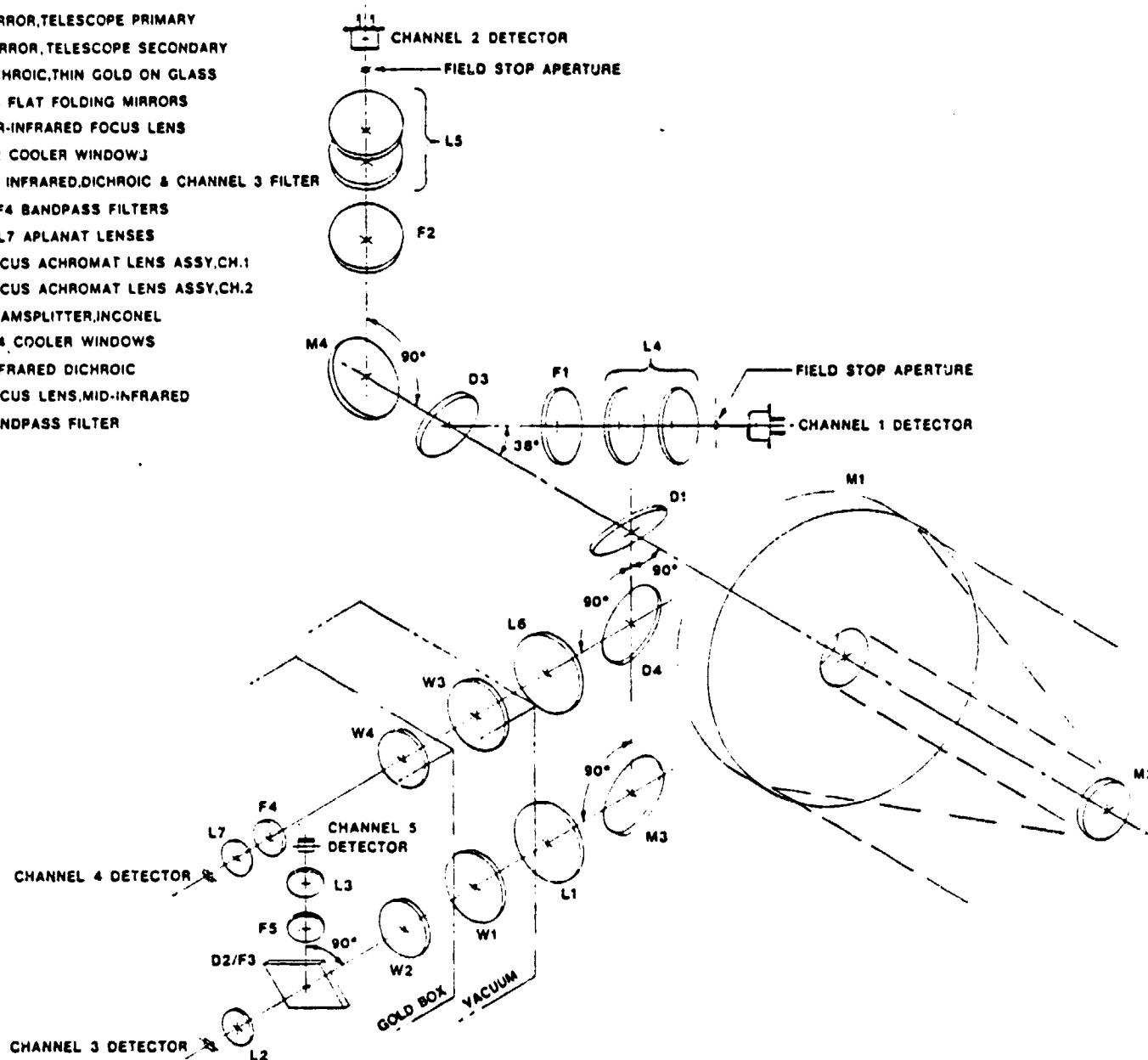


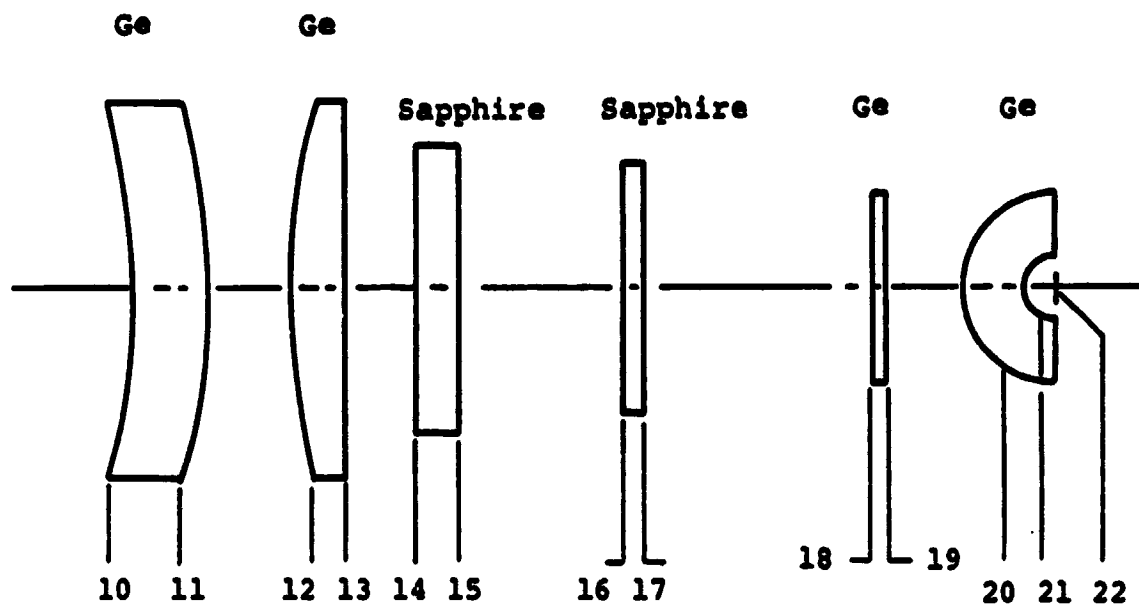
FIGURE 2-2 INFRARED DICHROIC BEAMSPLITTER ARRANGEMENT

M1 MIRROR, TELESCOPE PRIMARY
 M2 MIRROR, TELESCOPE SECONDARY
 D1 DICHOIC, THIN GOLD ON GLASS
 M3, M4 FLAT FOLDING MIRRORS
 L1 FAR-INFRARED FOCUS LENS
 W1, W2 COOLER WINDOWJ
 D2/F3 INFRARED, DICHOIC & CHANNEL 3 FILTER
 F1, F2, F4 BANDPASS FILTERS
 L2, L3, L7 APLANAT LENSES
 L4 FOCUS ACHROMAT LENS ASSY, CH.1
 L5 FOCUS ACHROMAT LENS ASSY, CH.2
 D3 BEAMSPLITTER, INCONEL
 W3, W4 COOLER WINDOWS
 D4 INFRARED DICHOIC
 L6 FOCUS LENS, MID-INFRARED
 F5 BANDPASS FILTER



AVHRR/2 OPTICAL CONFIGURATION

FIGURE 2-3

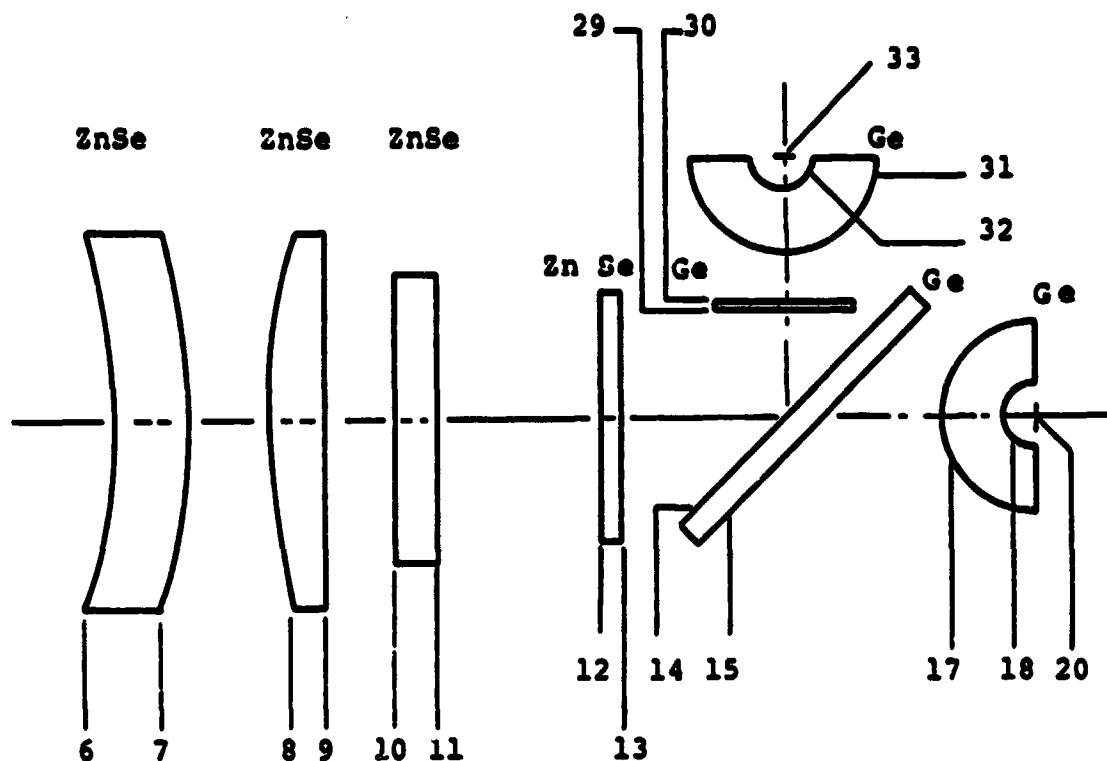


<u>SURFACE</u>	<u>RADIUS</u> <u>(m.m.)</u>	<u>AXIAL</u> <u>THICKNESS</u> <u>(m.m.)</u>	<u>HALF</u> <u>APERTURE</u> <u>(m.m.)</u>
10	-101.905	6.364	19.716
11	-91.542	17.283	20.619
12	135.471	6.353	18.832
13	255.382	23.898	18.113
14	"	3.175	8.67
15	"	11.681	8.22
16	"	1.570	5.38
17	"	2.990	5.16
18	"	1.010	4.44
19	"	1.143	4.38
20	3.900	2.997	3.55
21	1.930	1.570	1.53
22	IMAGE PLANE, CHANNEL 4.		

* The two Ge lenses on the left are sized for the extended F.O.V., all others for Inst. F.O.V.

RELAY OPTICS FOR AVHRR/2, CHANNEL 4.

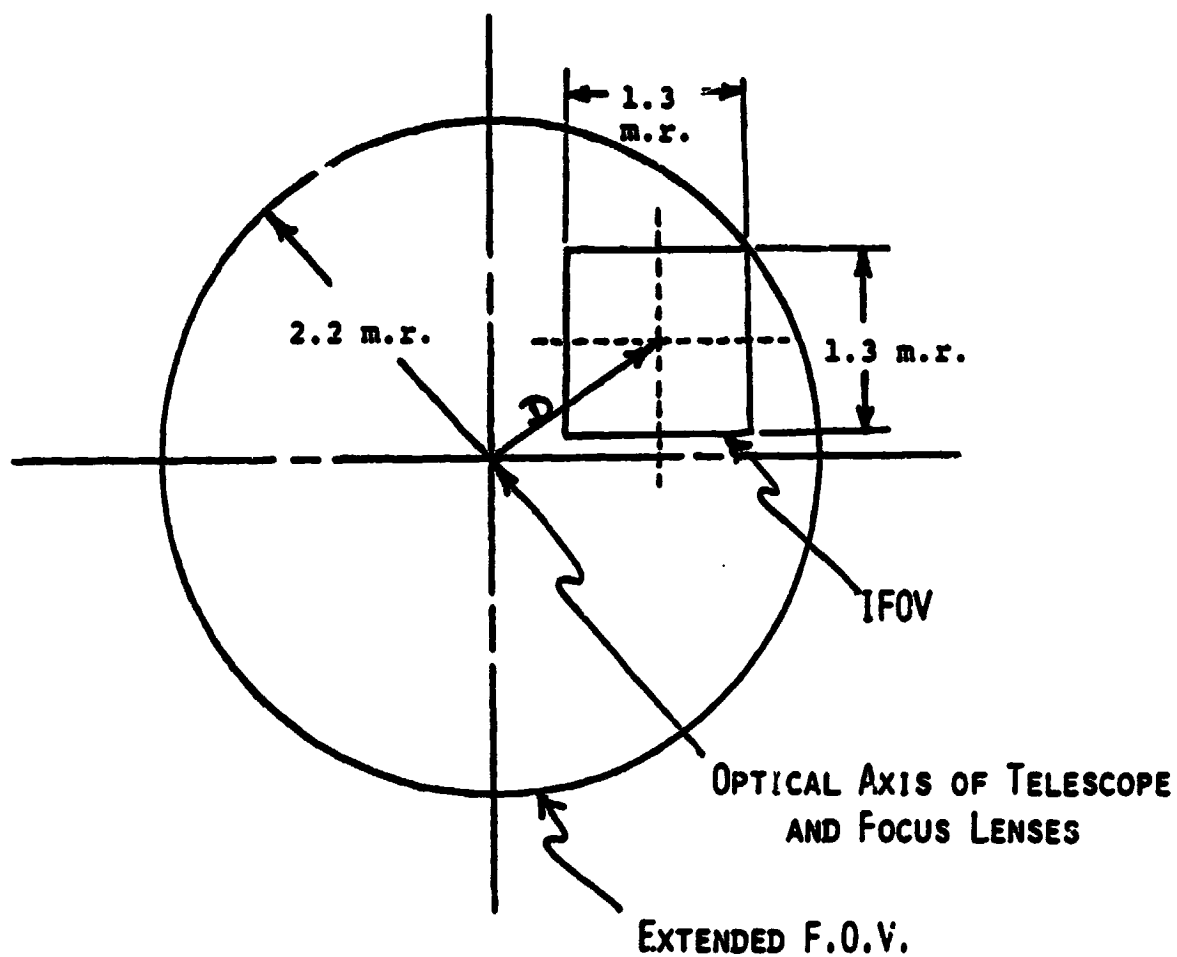
FIGURE 2 - 4



<u>SURFACE</u>	<u>RADIUS (m.m.)</u>	<u>AXIAL THICKNESS (m.m.)</u>	<u>HALF APERTURE (m.m.)</u>
6	-57.92	7.00	20.64
7	-65.481	15.00	22.20
8	108.189	7.00	23.17
9	-597.276	4.363	22.73
10	"	4.780	16.16
11	"	17.404	15.67
12	"	1.570	11.28
13	"	15.255	11.12
14	"	2.540	ELLIP.
15	"	7.600	ELLIP.
17	4.580	2.997	4.47
18	2.800	2.480	2.49
20	IMAGE PLANE, CHANNEL 3		
14	"	11.500	ELLIP.
29	"	1.010	4.496
30	"	0.254	4.434
31	3.900	2.997	3.685
32	1.928	1.653	1.621
33	IMAGE PLANE, CHANNEL 5		

* The two ZnSe lenses on the left are sized for the extended F.O.V., all others for Inst. F.O.V.

RELAY OPTICS FOR AVHRR/2 CHANNELS 3 & 5
FIGURE 2 - 5



D = MAXIMUM APLANAT-DETECTOR OFFSET = 1.27 M.R.

D = 0.67 M.M. (=0.026")

ILLUSTRATION OF EXTENDED FOV FOR INFRARED
CHANNEL REGISTRATION (MAXIMUM OFFSET SHOWN)
FIGURE 2- 6

degradation. This relaxes the requirement for perfect optical and mechanical alignment. The maximum amount of infrared detector-aplanat assembly offset of each infrared channel without any vignetting occurring is 0.026"; the extended FOV for Channels 1 and 2 is the same as for AVHRR/1 and has proved to be adequate for registration.

The calculated optical performance for the infrared channels is given in Figure 2-7. The calculated performance of the AVHRR/2 infrared channels is generally as good or better than for AVHRR/1. The sine wave MTF for the three infrared channels of AVHRR/2 is also given versus spatial frequency and target size in Figures 2-8, 2-9 and 2-10. The calculated performance is well above our internally specified minimum values in all cases. The measured optical performance of both the OTM and PFM met the internally specified limits.

CHANNEL 3

SPATIAL FREQUENCY	ON AXIS		IFOV EDGE		EFOV EDGE	
	MOD 1	MOD 2	MOD 1	MOD 2	MOD 1	MOD 2
19 c/R	>99	>99	>99	>99	>99	>99
256 c/R	98	97.3	97	97.3	96	96.9
382 c/R	97	95.5	95	95.8	94	94.6

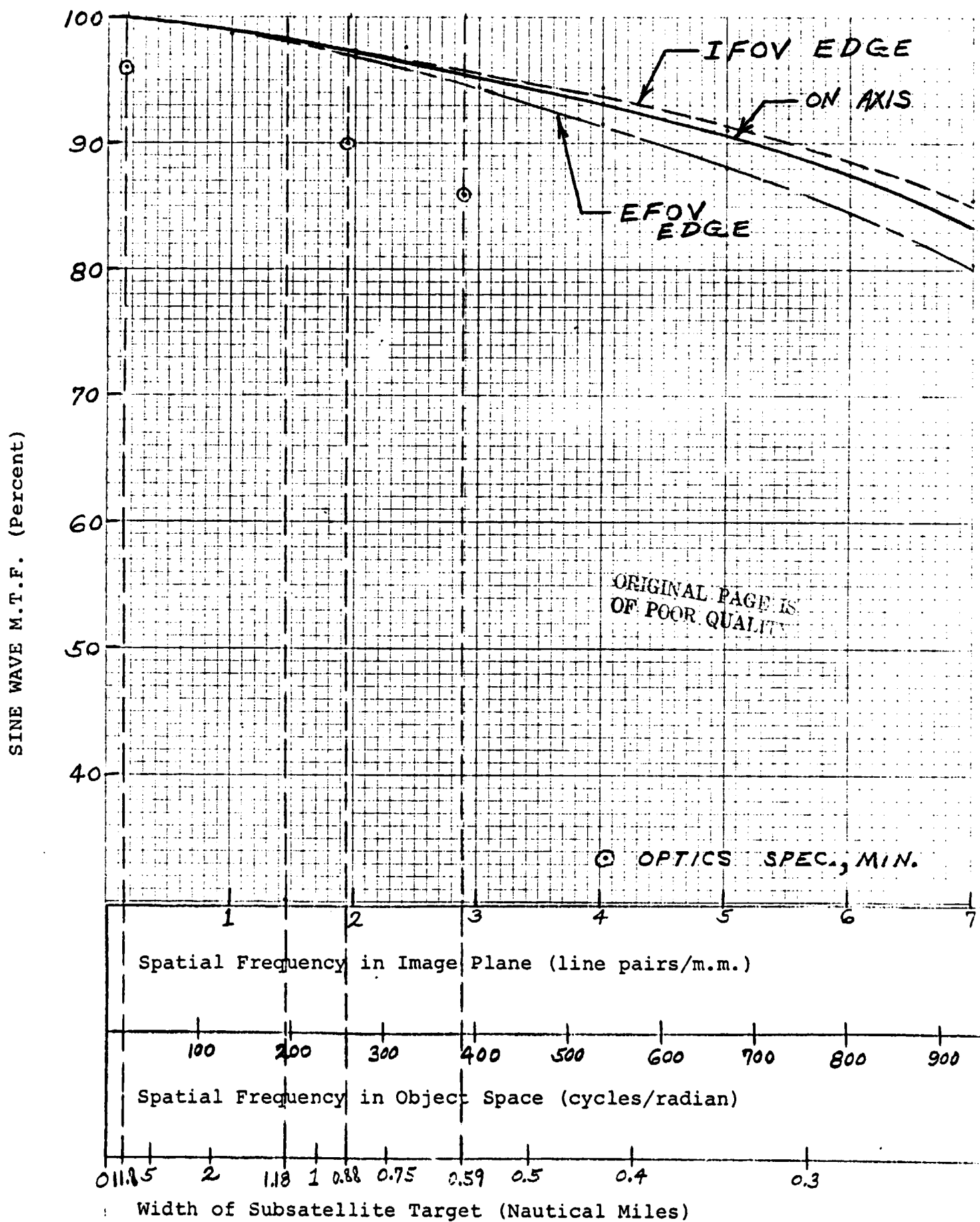
CHANNEL 4

SPATIAL FREQUENCY	ON AXIS		IFOV EDGE		EFOV EDGE	
	MOD 1	MOD 2	MOD 1	MOD 2	MOD 1	MOD 2
19 c/R	>99	>99	>99	>99	>99	>99
256 c/R	98.5	99.0	98	99.0	96	99.0
382 c/R	97.7	98.2	97	98.2	94	98.2

CHANNEL 5

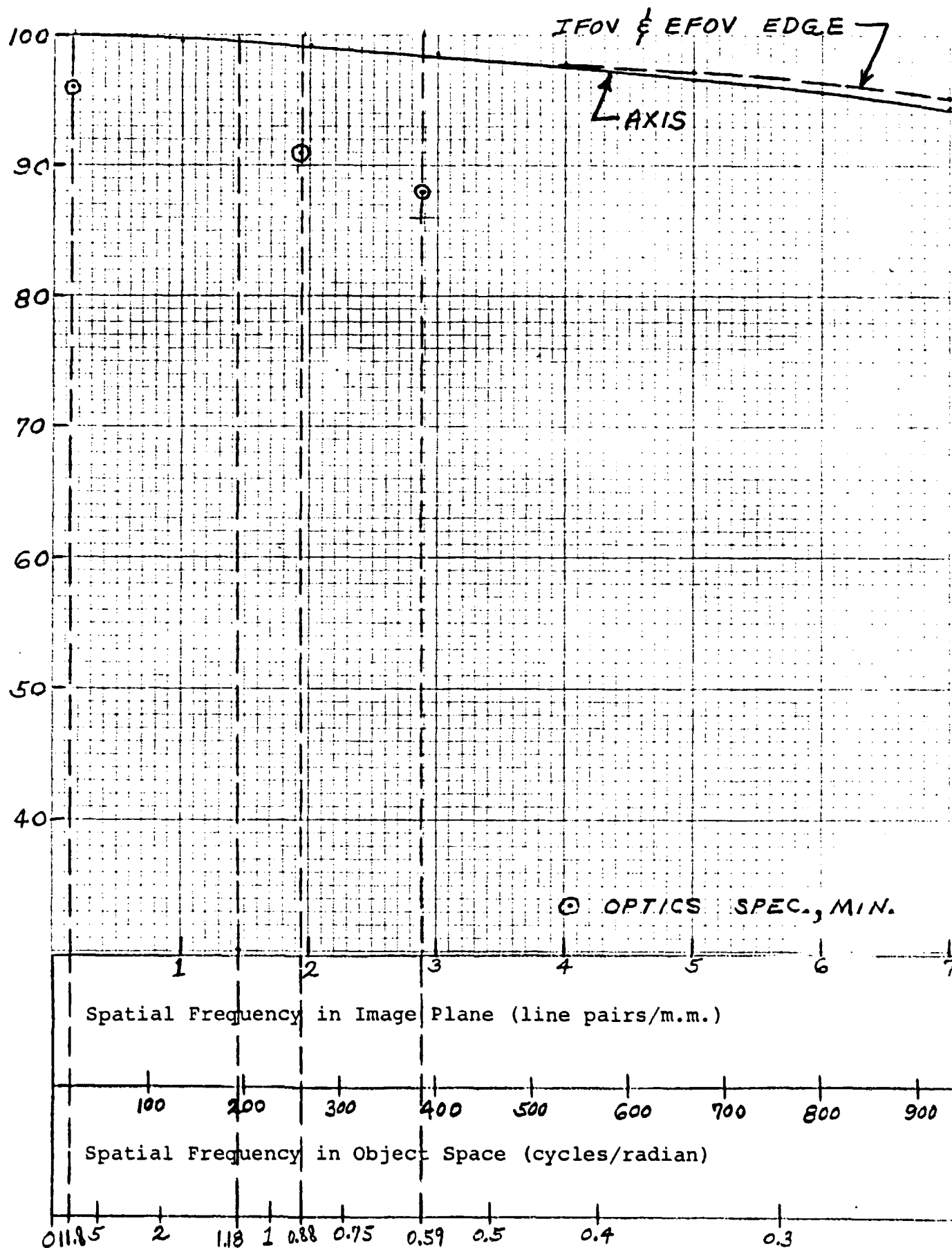
SPATIAL FREQUENCY	ON AXIS		IFOV EDGE		EFOV EDGE	
	MOD 1	MOD 2	MOD 1	MOD 2	MOD 1	MOD 2
19 c/R	--	>99	--	>99	--	>99
256 c/R	--	97.6	--	97.6	--	97.1
382 c/R	--	96.0	--	96.0	--	95.2

COMPARISON OF CALCULATED MTF FOR
AVHRR/1 & AVHRR/2
FIG. 2 - 7



Channel 3 Optical M.T.F. vs. Spatial Freq. (or Tgt. Size)
FIGURE 2 - 8

SINE WAVE M.T.F. (Percent)



Spatial Frequency in Image Plane (line pairs/m.m.)

Spatial Frequency in Object Space (cycles/radian)

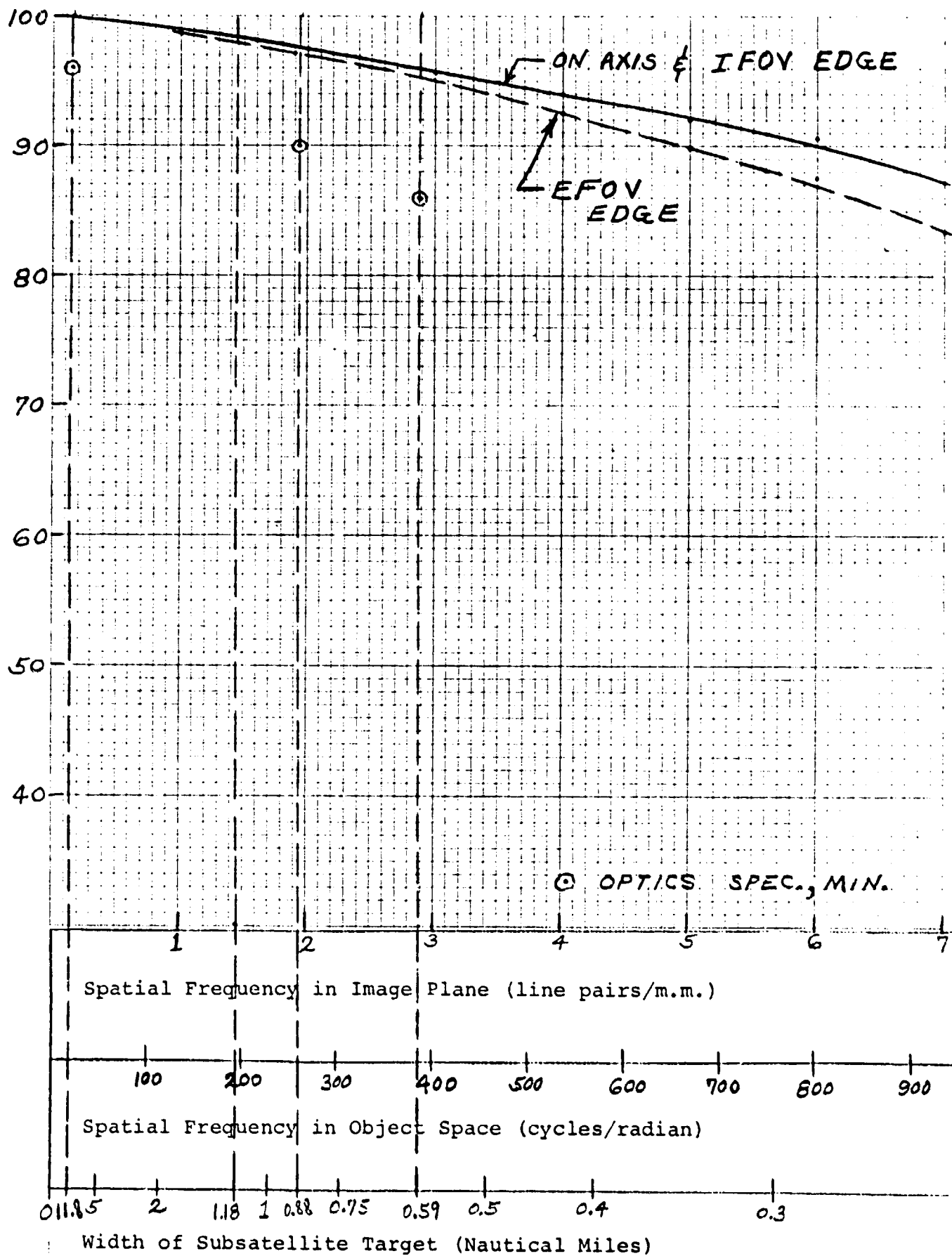
Width of Subsatellite Target (Nautical Miles)

Channel 4 Optical M.T.F. vs. Spatial Freq. (or Tgt. Size)

FIG 2-9

2-11

SINE WAVE M.T.F. (Percent)



Channel 5 Optical M.T.F. vs. Spatial Freq. (or Tgt. Size)

FIG. 2 - 10

3.0 DETECTORS AND SENSITIVITY

In the infrared channels HgCdTe detectors are used in Channels 3 and 5 and an In Sb detector in Channel 4. These are purchased from outside manufacturers as indicated in Table 3-1 in accordance with detailed procurement specifications; some of the more pertinent performance requirements are also included in the table.

The sensitivity of the infrared channels can be expressed in terms of the NEAT (noise equivalent temperature difference between two large targets scanned by the instrument which produces a change in output voltage equal to the r.m.s. noise output voltage. The equations used to calculate the NEATs from the AVHRR system parameters are found in Section 2.0 of the AVHRR/1 Technical Description document, Vol. 1 (Contract NAS5-21900). Using the detector detectivities and degradation factors listed in Table 3-2 for AVHRR/2, the NEAT has been calculated for two values of optical system transmission for each infrared channel. The expected transmission (τ) was obtained from typical measured data achieved on AVHRR/1 or, in the case of new components, values estimated to be realistic from past experience. The worst case transmission values listed in Table 3-2 is the product of the minimum specified transmission for each optical component given on the part procurement drawings. The expected and worst case NEAT values given in Table 3-2 are the corresponding NEAT values calculated from these two values of optical system transmission. The calculated worst case NEAT values meet or exceed the specified instrument requirements for all three channels.

Channel	1	2	3	4	5
Type	Silicon	Silicon	HgCdTe	InSb	HgCdTe
Manufacturer	IR Ind.	IR Ind.	Honeywell	Cincinnati Electronics	Honeywell
D*	--	--	2.3×10^{10}	--	2.3×10^{10}
Responsivity	0.37 A/W	0.54 A/W	5500 V/W	--	5500 V/W
Quantum Efficiency	--	--	--	>0.75	--
Bias	-15 volts	-15 volts	1.2 mwatt	~15 mvolts	1.2 mwatt
Size	0.100 in	0.100 in	0.0068 in	0.0068 in	0.0068 in

AVHRR/2 DETECTOR CHARACTERISTICS
TABLE 3-1

<u>PARAMETER</u>	<u>CH 3</u>	<u>CH 4</u>	<u>CH 5</u>	
DETECTOR D*	2.3×10^{10}	--	2.3×10^{10}	$\text{CMHZ}^{\frac{1}{2}} \text{W}^{-1}$
DEGRADATION FACTOR	2.1*	1.6	2.1*	
WORST CASE SYSTEM T	.23	.32	.21	
EXPECTED T	.36	.42	.33	
EXPECTED NE Δ T	.08	.05	.09	K @ 300K
WORST CASE NE Δ T	.11	.07	.13	K @ 300K
SPEC. NE Δ T	$\leq .12$	$\leq .12$	$\leq .13$	K @ 300K

D* IS GUARANTEED MINIMUM AT 108K

CALCULATIONS ARE FOR NOMINAL SPECTRAL BANDPASS

*DEGRADATION FACTOR ACHIEVED IN CH 3 OF PFM WAS 1.6

AVHRR/2 THERMAL CHANNELS' SENSITIVITY PARAMETERS

TABLE 3-2 AVHRR/2 THERMAL CHANNELS' SENSITIVITY PARAMETERS

4.0 SPECTRAL RESPONSE

Channels 1, 2, and 4 of AVHRR/2 will be identical to the AVHRR/1 Flight Model responses. These are shown in Figure 4-1 thru Figure 4-3. The component changes in Channel 4 which could affect spectral response are the re-lacemement of one mirror reflectance by a dichroic reflectance (which is flat between 3.5 and 4.0 microns) and the replacement of the Irtran 2 cooler windows by sapphire windows (having a more uniform spectral transmission).

The calculated spectral responses for Channels 3 and 5 O.T.M. instrument are given in Figure 4-4. It should be noted that an aplanat-detector incidence angle factor has not been incorporated into these calculated responses as was found necessary on the AVHRR/1 program to obtain agreement with measured data. The calculated responses indicate that no significant spectral overlap is anticipated; this occurs primarily because the bandpass filters manufactured by OCLI for Channel 3 were near the short wavelength limit of the allowable tolerance whereas Channel 5 filters are very near nominal values. The very steep cuton and cutoff slopes actually achieved on the manufactured filters also is responsible for the negligible spectral overlap.

Figure 4-5 shows the worse case spectral overlap between Channels 3 and 5 using idealized (trapezoidal) shaped response curves. The calculated worse case spectral overlap of 8.5% is not expected to cause any serious problem in data analysis even if it should get that large.

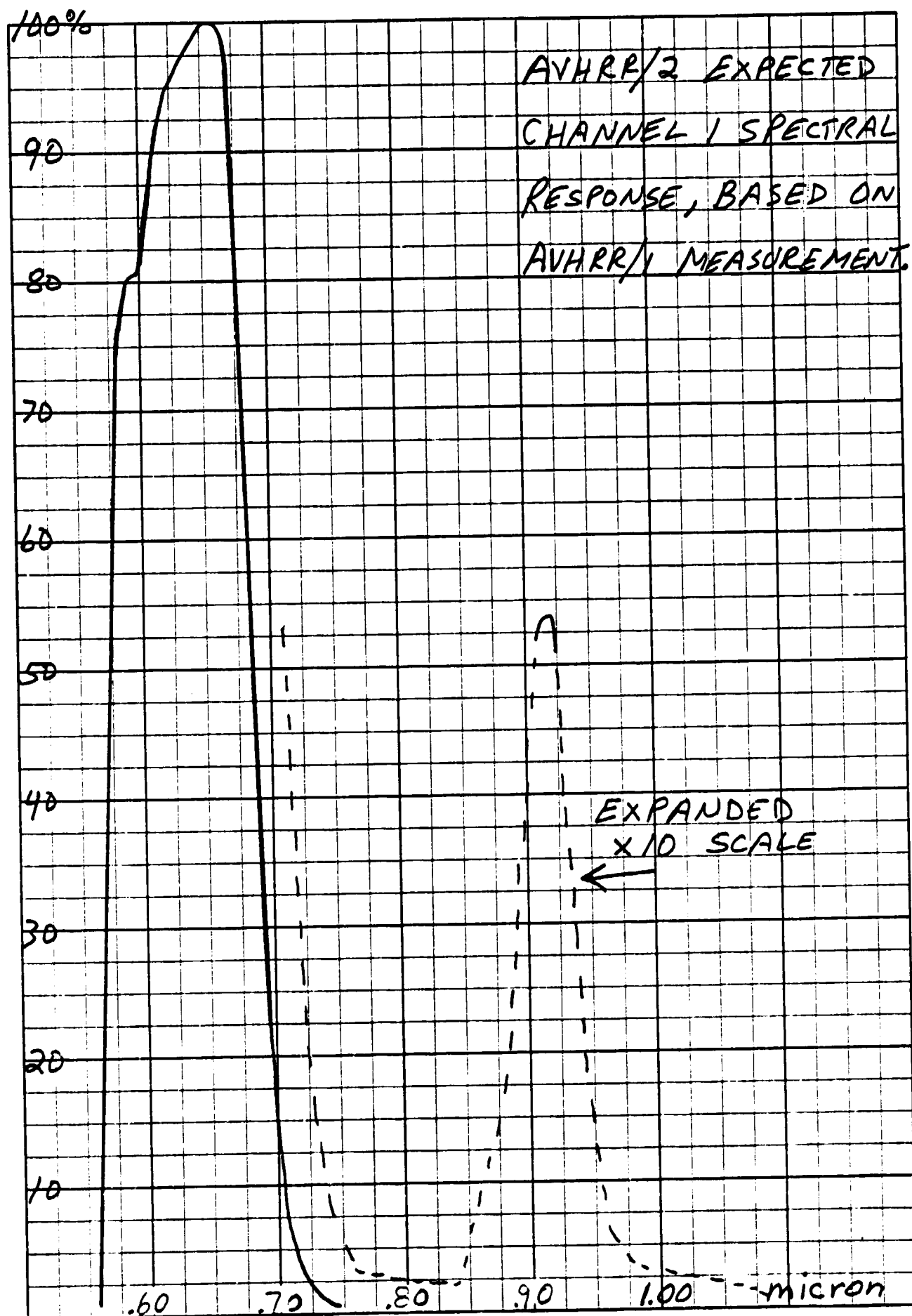


FIGURE 4 - 1

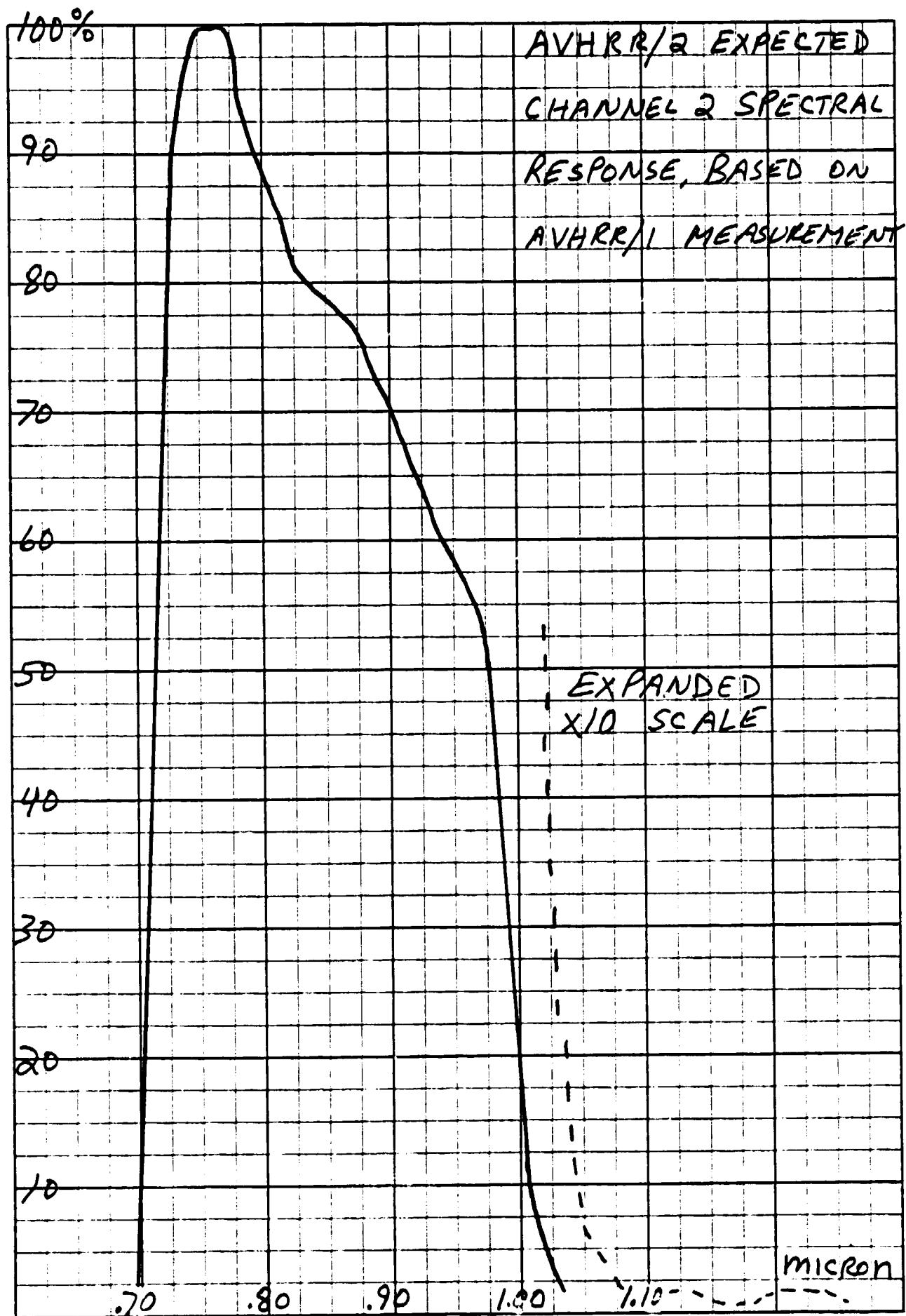


FIGURE 4 - 2

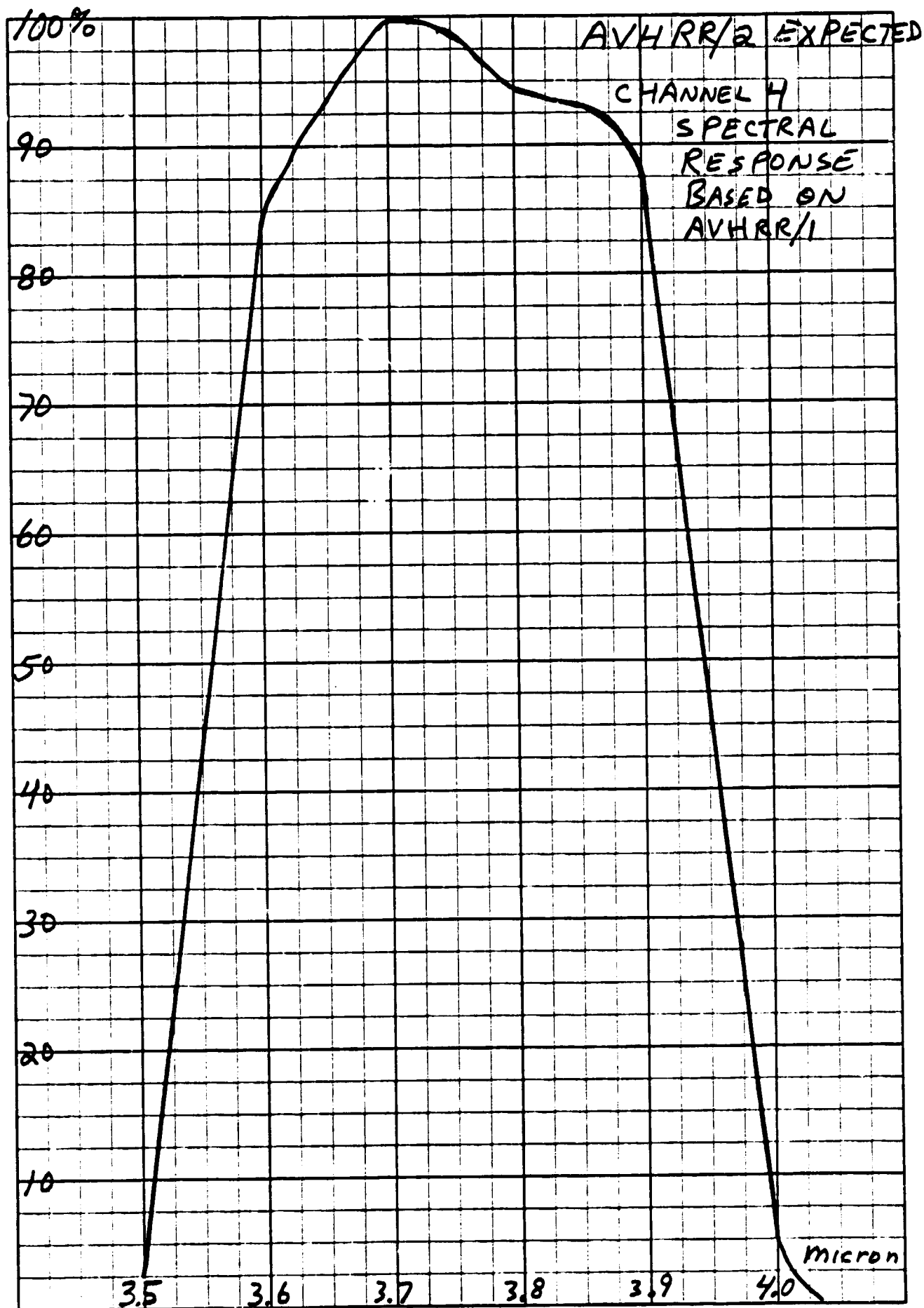
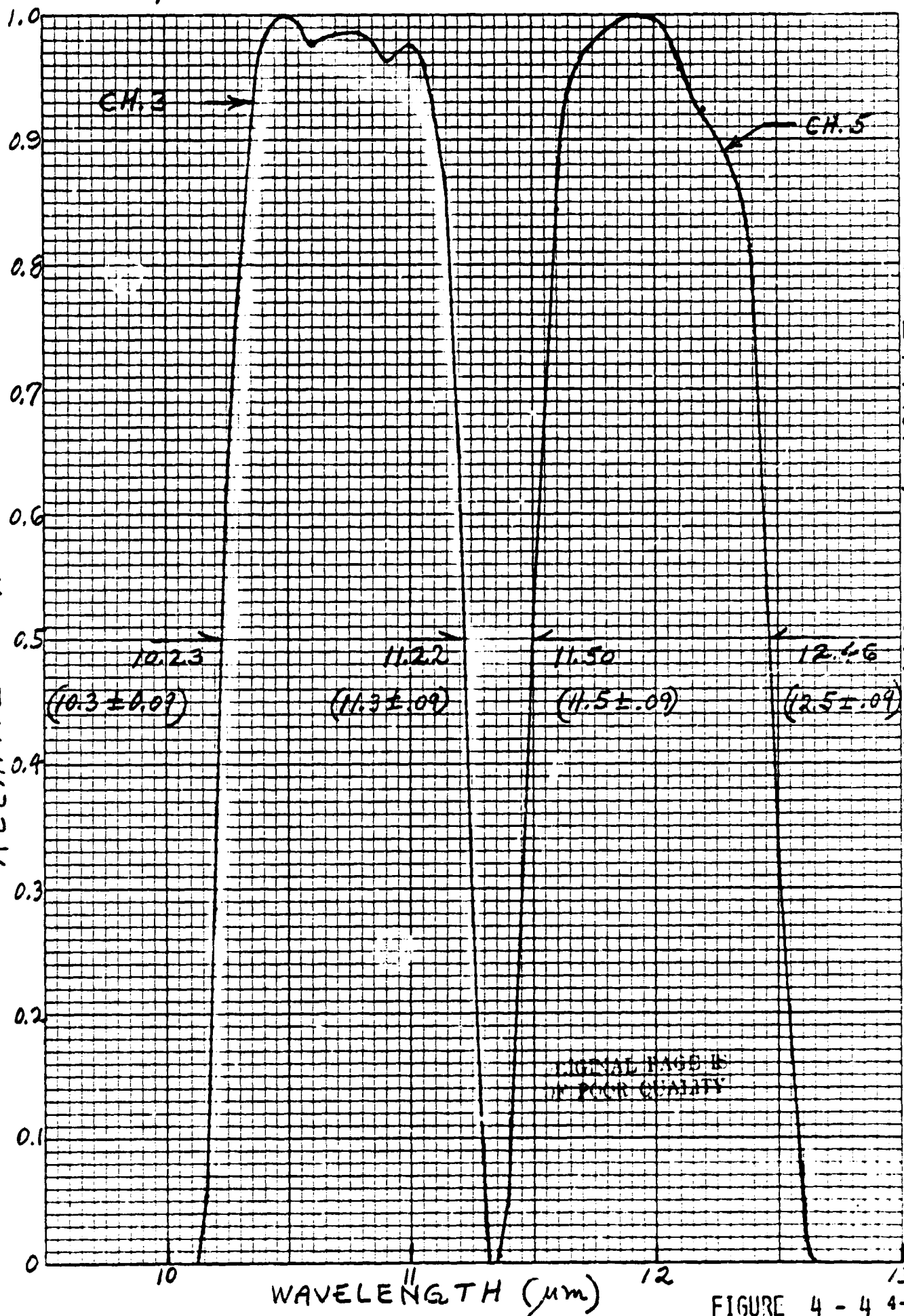


FIGURE 4 - 3

46 0703
RESPONSE
RELATIVE
10 X 10 10 THE INCHES
NEUFFEL & ESSER CO. MADE IN U.S.A.



NOTE: NO INCIDENCE ANGLE EFFECT ON APLANAT OR DETECTOR IS INCLUDED; VALUES IN PARENTHESES ARE SPECIFIED

Worse Case Spectral Overlap for 4% Slope & Idealized Response

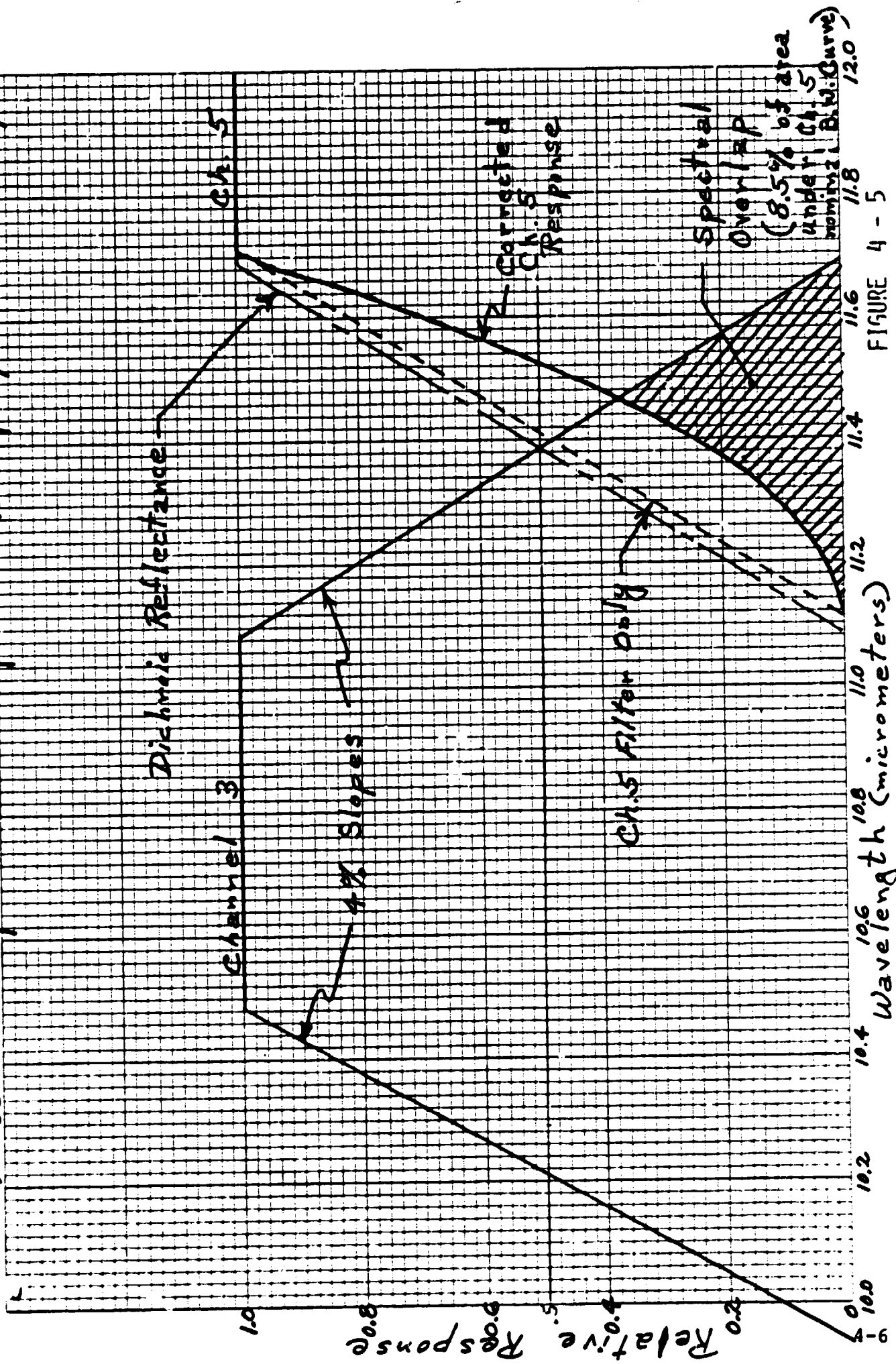


FIGURE 4 - 5

5.0 RADIANT COOLER

The basic design of the radiant cooler is unchanged from that used in Mod 1 (AVHRR Technical Description, Rev. B, Nov. 15, 1974, Section 6.0). In particular, we have preserved the design from AVHRR/1 to the maximum extent possible, consistent with the additional cool channel. As a result, the exterior of the cooler is unchanged from the Mod I design; this includes the earth shield, shield covers, and the radiating (black) areas for both stages. In addition, the rear surface of the radiator is insulated by means of a multilayer blanket, in the same manner as AVHRR/1. The common fronts on the coolers allow the use of a common bench cooler for both the four and five channel instruments.

The nominal characteristics of the radiant cooler for the AVHRR/2 are given in Tables 5.1 and 5.2. All the thermal predictions are based on the analytical model established on the Mod 1 program. The thermal influence of the third cooled channel shows up as changes in the optical port loadings from the second optical opening, as an increase in the insulated area on both stages that reflects the larger cooled optical assembly, and as an increase in the conductive input to the patch that reflects the large mass to be supported.

The thermal impact on the patch produced by the additional optical port is minimized by proper channel separation and spectral filtering. Thus Channels 3 and 5 (10.2 to 11.2 μ m and 11.9 to 12.9 μ m) share a common optical port to the cooler and are separated by a dichroic on the patch in the manner of Channels 3 and 4 in Mod 1. At the same time, the Zn Se radiator window is supplied with a band-pass filter (9.6 μ m — 13.2 μ m) that restricts the housing radiation that reaches the patch. The second optical port is used by Channel 4 (3.55 to 3.93 μ m). Here the use of a sapphire radiator window reduces the housing radiation that reaches the patch to a negligible value.

As a result of our experience on AVHRR/1, we have simplified the electrical wiring; all leads between the housing and radiator (first stage) are now copper and all leads between the radiator and patch (second stage) are nickel. The additional electrical leads (two to the third infrared sensor and two to the second heated radiator window) plus the change to all copper wires has increased the thermal conductance between the housing and the radiator from $1.905 \times 10^{-3} \text{ WK}^{-1}$ to $2.237 \times 10^{-3} \text{ WK}^{-1}$.

The thermal analysis was carried out for an instrument base-plate regulated by the spacecraft louver system at a nominal 15°C. The corresponding cooler housing temperature is 17.5°C, while the infrared relay immediately in front of the cooler is at 20°C.

The result of the alterations in the optical chain is to actually reduce the optical port loading on the patch, from a nominal 25.3 mW in Mod 1 to 16.4 mW in Mod 2. Part of this reduction is used to the added infrared detector bias (1.2 mW) and part for the additional conductive input (4.8 mW) from the additional mechanical support, additional electrical leads (2), and change to all nickel wires. The remainder (2.9 mW) partially offsets the increased insulation (rear) area on the patch and the increased radiator

temperature (from its increased insulation area, thermal conductance, and optical port loading).

The in-orbit control power of 34.0 mW at the 105K control point corresponds to an uncontrolled temperature of 95.4K, so that the required thermal margin is achieved.

A detailed comparison of this prediction with the results of in-chamber tests on the Optical Test Model (OTM) of the radiant cooler is made in Section 5.5. When corrected to the nominal in-orbit conditions, the tests yielded a mean radiator temperature of 170.85K, a mean uncontrolled patch temperature of 97.0K, and a mean control power for operation at 105K of 29.05mW. The differences between the analytical model and the test measurements are explored further in Section 5.5.

5.1 Cover Temperatures

Both the vertical and horizontal earth shields are insulated from external inputs by shield covers. The three optically polished shields are thermally and mechanically connected. However, the two vertical covers are not connected to the horizontal cover. The cover temperatures are determined by the thermal balance equation given in Figure 5.1. The results are listed in Table 5.3 for the complete range of orbit normal to sun angles (0° to 68°) and for the nominal (833 km) and minimum (74 km) altitudes. The shading by the earth ends at a sun angle of $\beta_s = 90^\circ - \beta_e$, where β_e is nadir to earth tangent line angle; the temperature of the horizontal cover is a maximum at this point. The nominal orbit (3:30 PM/8:30 AM) corresponds to a sun angle of 37.5° .

TABLE 5.3
Earth Shield Cover Temperatures

$\beta_s \rightarrow$	@ 833km ($\beta_e = 62.17^\circ$)				@ 741km ($\beta_e = 63.61^\circ$)			
	0°	27.83°	37.5°	68°	0°	26.39°	37.5°	68°
Horizontal	232.0	241.9	238.6	238.7	233.5	242.8	239.7	240.0
Vertical	167.8	187.4	190.1	195.7	170.2	188.4	191.5	197.0

All temperatures in kelvins.

TABLE 5.1
Nominal Characteristics of the Radiator (1st Stage)

Temperature (a)	168.8	K	
Power radiated (a)	1.590	W	
Radiating area	55.2	in ²	
Conductive input (a)	0.272	W	17.1%
Insulation input (a)	0.391	W	24.6
Earth input	0.198	W	12.5
Covers input	0.398	W	25.0
Optical port input (a)	0.331	W	20.8
dT/dφ (b)	2.14	K/0.1W	

(a) For housing 17.5°C, optics at 20°C.
(b) Rate of change of temperature with input power at temperature shown.

TABLE 5.2
Nominal Characteristics of the Patch (2nd Stage)

Temperature (a)	105	K	
Power radiated	96.6	mW	
Radiating area	22.4	in ²	
Conductive input (b)	15.3	mW	15.8
Insulation input	18.5	mW	19.2
Joule heat input	3.5	mW	3.6
Optical port input	16.4	mW	17.0
Shield input	8.9	mW	9.2
Control power	34.0	mW	35.2
dT/dφ	0.32K	(mW) ⁻¹	@ 96K

(a) Nominal control point.
(b) Including effect of support shields.

Note: Values are for in-orbit operation.

Figure 5.1 Cooler Earth Shield Cover Thermal Balance Equation

$$\epsilon_c \sigma T_c^4 = F_{ce} (\epsilon_c W_e + \alpha_c W_r) + \alpha_c S_o \langle \sin i \rangle,$$

where ϵ_c = emissivity = 0.72 (silvered Teflon)
 α_c = solar absorptivity = 0.08
 F_{ce} = view factor from cover to earth; $\sin^2 \beta_e$ for a horizontal cover and $\frac{1}{\pi} (\beta_e - \sin \beta_e \cos \beta_e)$ for a vertical cover, where β_e is the mean angle from nadir to the earth-tangent line.

$\langle \sin i \rangle$ = orbital average of the solar incidence angle, taken to be zero when the cover is shaded from direct sunlight; $\frac{1}{\pi} \sin \beta_s (1 - \sin \Delta u_e)$ for a horizontal surface and $\frac{1}{2\pi} \sin \beta_s (1 + \cos \Delta u_e)$ for a vertical surface.

Δu_e = $\arccos (\cos \beta_e / \sin \beta_s)$; zero when $\sin \beta_s \leq \cos \beta_e$, i.e., when the spacecraft is in direct sunlight throughout its orbit.

W_e = infrared exitance of earth = $2.1 \times 10^{-2} \text{ Wcm}^{-2}$

W_r = reflected solar exitance of earth =
 $1.68 \times 10^{-2} \sin \beta_s \text{ Wcm}^{-2}$

S_o = solar constant = 0.14 Wcm^{-2}

5.2 Radiator Thermal Analysis

The radiator and earth shield have a temperature, T_r , that is given in Figure 5.2. The thermal conductance, K_r , between the cooler housing and the first stage of cooling consists of $1.725 \times 10^{-3} \text{ WK}^{-1}$ from the synthane support tubes and $0.512 \times 10^{-3} \text{ WK}^{-1}$ from the copper electrical leads (2 leads of 0.0039 inch diameter and 18 leads of 0.0030 inch diameter, all with a free length of 3.15 inches).

The radiator temperature varies with sun angle and altitude as a result of changes in the direct load from the earth (ϕ_{er}) and the indirect load from the shield covers (ϕ_{sr}). The results are given in Table 5.4 for a nominal blanket^{cr} insulation factor of 65; the nominal temperature (833 km, $\beta_s = 37.5^\circ$) is 168.8K.

TABLE 5.4
Radiator Temperatures

$\beta_s \rightarrow$	0°	$27.83^\circ/26.39^\circ$	37.5°	68°
@ 833 km	165.3	168.8	168.8	169.8
@ 741 km	166.2	169.5	169.7	170.7

Temperature in kelvins.

Nominal baseplate temperature (15°C).

Nominal insulation blanket ($s_i = 65$).

To study the effect of the multilayer blanket on thermal performance, we varied its insulation factor to a minimum of 50 (experimental value on the AVHRR/1 breadboard model). The corresponding radiator temperatures are 171.2K in the nominal orbit and 173.2K in the worst case orbit.

Figure 5.2 Cooler First Stage Thermal Balance Equation

$$\epsilon_r \sigma A_r T_r^4 = \phi_{er} + \phi_{cr} + \phi_i + \phi_k + \phi_o$$

- where ϕ_{ab} = radiant power from a that is absorbed in b
- e = earth (infrared and reflected sunlight)
- r = black radiator, c = shield covers
- ϕ_a = input from instrument through a
- i = multilayer insulation; k = supports and wires;
o = optical port
- $\phi_{er} = F_{re} (\epsilon_r W_e + \alpha_r W_r) A_r$
- $\phi_{cr} = \frac{\sigma A_c}{S_c} (T_c^4 - T_r^4) + K_c (T_c - T_r)$ for each cover
- F_{ab} = view factor from a to b; A_a = area of a
- ϵ_a = emissivity of a; α_a = solar absorptivity of a
- W_e = earth infrared exitance = $2.1 \times 10^{-2} \text{ Wcm}^{-2}$
- W_r = earth reflected sunlight exitance
= $1.68 \times 10^{-2} \sin \beta_s \text{ Wcm}^{-2}$; β_s = orbit normal to sun angle
- A_c (horizontal) = 104 in^2 ; A_c (2 vertical) = 7.5 in^2
- A_r = 55.2 in^2 ;
- F_{re} = 0.01837 (833 km), 0.02157 (741 km); computer calculations
- $\epsilon_r = \alpha_r = 0.97$ (honeycomb cavity array covered with black paint)
- $S_c = \frac{2}{\epsilon_c} - 1$; ϵ_c = emissivity of gold plating on facing surfaces of shield and cover = 0.035.
- K_c = thermal conductance of supports between shield and cover
= $2.66 \times 10^{-3} \text{ WK}^{-1}$ (horizontal),
= $2.07 \times 10^{-3} \text{ WK}^{-1}$ (2 vertical)
- T_c = cover temperature

Figure 5.2 Cooler First Stage Thermal Balance Equation
(Continued)

$$\phi_i = \frac{\sigma A_i}{S_i} (T_h^4 - T_r^4); A_i = 110 \text{ in}^2$$

$$S_i = \text{insulation factor of multilayer blanket between housing and radiator} = 65 \text{ (nominal), } 50 \text{ (minimum).}$$

$$T_h = \text{housing temperature} = 290.5\text{K (17.5}^\circ\text{C)}$$

$$\phi_k = K_r (T_h - T_r); K_r = \text{thermal conductance between h and r} = 2.237 \times 10^{-3} \text{ WK}^{-1}$$

$$\phi_o = 0.331 \text{ W (Section 5.4)}$$

5.3 Patch Thermal Analysis

The thermal balance equation for the patch is the solution to the equation described in Figure 5.3. The joule heat consists of 1.2 mW for each HgCdTe detector and 1.1 mW for the temperature sensor. The optical port loading is for a nominal baseplate temperature of 15°C and for an optics temperature of 20°C. The thermal conductance, K , between the radiator and patch consists of $1.414 \times 10^{-4} \text{ WK}^{-1}$ from the mechanical supports (3/16-inch OD x 5/32-inch ID and 2.00 inch free length) plus $0.630 \times 10^{-4} \text{ WK}^{-1}$ from the electrical leads (12,0.045-inch diameter nickel wires wound around the supports for 6.00 inches of free length).

The dual heat mode multiplier, M , was calculated by the technique described in the Technical Description of Mod 1 (Rev. B, Nov. 15, 1974, memorandum at the end of Section 6.0). A shield emissivity, ϵ_s , of 0.035 was used in the calculation and the analysis was carried out for the shield at the radiator temperature (i.e., the thermal gradient was evaluated at $x = \lambda$).

The patch temperature varies with sun angle and altitude as a consequence of resultant variations in the radiator temperature. The results are given in Table 5.5 for a nominal radiator blanket insulation factor of 65; the nominal uncontrolled patch temperature is 95.4K, which corresponds to a control power of 34.0 mW at 105.0K.

TABLE 5.5
Patch Temperatures and Control Powers

$\beta_s \rightarrow$	0°	27.83°/26.39°	37.5°	68°
@ 833 km	94.1(38.0)*	95.4(34.0)	95.4(34.0)	95.8(32.9)
@ 741 km	94.4(37.0)	95.7(33.3)	95.7(33.0)	96.1(31.9)

*Control power in milliwatts at 105.0K.

Temperature in kelvins; 15°C instrument baseplate; radiator insulation factor of 65.

For a minimum radiator insulation factor of 50, the nominal orbit uncontrolled patch temperature is increased from 95.4K to 96.3K (34.0 mW to 31.3 mW of control power) and the worst case orbit uncontrolled patch is increased from 96.1K to 97.1K (31.9 mW to 28.9 mW). We will therefore have an in-orbit margin of greater than 10K with respect to the 108K control point under all conditions of spacecraft altitude, sun angle, and insulation factor.

The equation in Figure 5.3 does not include the input present during chamber testing as a result of reflection of the radiator power from the cold space target. Based on thermal tests and their analyses (Section 6.7 of the Mod 1 Technical Description) we estimate this input to be given by

$$7.5 \times 10^{-3} \left(\frac{T_r}{164} \right)^4 \text{ W}$$

for the 22.4 in² black radiating area. Under nominal conditions, this input is $8.42 \times 10^{-3} \text{ W}$ and increases the uncontrolled patch temperature to 98.0K, an increase of 2.6K.

$$\sigma \epsilon_p A_p T_p^4 = \phi_s + \phi_k + \phi_i + \phi_j + \phi_o$$

where	p	=	patch
	s	=	earth shield (upper side)
	k	=	thermal conductance including the influence of radiative inputs from the support shields
	i	=	gold-to-gold radiative insulation
	j	=	joule heat of detectors and temperature sensor
	o	=	optical port
	ϕ_s	=	$\sigma \epsilon_p \epsilon_s A_p F_{ps} T_r^4$
	ϕ_k	=	$M K_p (T_r - T_p)$; M = dual mode multiplier
	ϕ_i	=	$\frac{\sigma A_i}{S_i} (T_r^4 - T_p^4)$; $S_i = \frac{2}{\epsilon_i} - 1$
	ϕ_j	=	$3.5 \times 10^{-3} \text{ W}$
	ϕ_o	=	$8.21 \times 10^{-3} + 8.214 \times 10^{-12} (T_r + 9K)^4 \text{ W}$ (Section 5.4)
	ϵ_p	=	0.97 (black paint on honeycomb cavity array)
	ϵ_s	=	0.035 (vacuum deposited aluminum)
	ϵ_i	=	0.035 (gold plate)
	A_p	=	22.4 in^2 ; $A_i = 41 \text{ in}^2$
	F_{ps}	=	0.3948 (computer calculation, including second reflections)
	K_p	=	$2.044 \times 10^{-4} \text{ WK}^{-1}$; M = 1.17

Figure 5.3 Cooler Second Stage Thermal Balance Equation

5.4 Optical Port Loading

The optical port loading was calculated from an analytical model developed on the Mod 1 program (AVHRR Technical Description, Rev. B, Nov. 15, 1974, Section 6.8). This model is based on three separate thermal tests of the radiant cooler. The dimensions and opening materials for Mod 2 are shown in Figure , together with the resultant view factors. These data can be used to calculate the optical loading on the radiator and patch for each of the optical ports in Mod 2.

The optical loading on the radiator is given by

$$\phi_{or} = \epsilon_1 \sigma T_0^4 A_1 [F_{12}'(1 - p_2) + (1 - F_{12}')]]$$

where A_1 equals πr_1^2 and p_2 is the fraction of housing temperature radiation passed by the radiator window. The radiator window for Channels 3 and 5 is Zn Se coated with a bandpass filter that transmits from 9.6 to 13.2 μm . The radiator window for Channel 4 is sapphire. The corresponding values of p_2 are 0.23 and 0.03. The emissivity, ϵ_1 , of the housing window is for greybody radiation emitted by the housing window or transmitted through the window from the optics. In Channels 3 and 5, the housing window is Zn Se and ϵ_1 is 0.9. In Channel 4, the housing window is sapphire and ϵ_1 is 0.6 (See Thermal Properties of Matter, Y.S. Touloukian and D. P. DeWitt, IFI/Plenum, 1972).

The emission temperature T_0 in Channels 3 and 5 is that of the relay optics or 293K (20°C); the emission temperature in Channel 4, however, is that of the housing window or 290.5K (17.5°C).

We then have

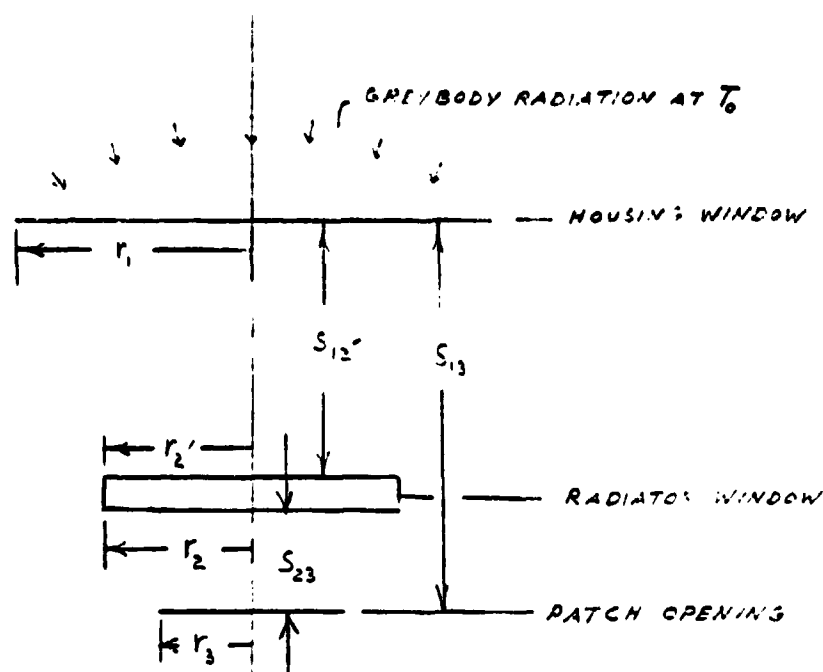
$$\phi_{or} \text{ (Chs. 3 and 5)} = 0.277\text{W, and}$$

$$\phi_{or} \text{ (Ch. 4)} = 0.054\text{W.}$$

The optical port loading on the patch consists of inputs from the ambient instrument optics and the radiator. We will restrict the radiator input to that from the inner window itself; radiation at the radiator temperature (i.e., the cold trap) is efficiently absorbed in the window. The input from the instrument to the patch is given by

$$\phi_{13} = \epsilon_1 \sigma T_0^4 p_2 \tau_2 F_{31} \gamma_3 A_3$$

where τ_2 is the transmittance of the inner window for greybody radiation at the temperature T_0 and where γ_3 is the effective absorptivity of the patch opening. For Channels 3 and 5, τ_2 is 0.9 and γ_3 is 0.773 (experimental value from Mod 1). For Channel 4, τ_2 is 0.95 and γ_3 is 0.9. For Channels 3 and 5, p_2 is again 0.23. In the case of Channel 4, τ_2 , p_2 , and γ_3 are for the narrow spectral band (3.55 to 3.93 μm) that is absorbed in the patch. (The patch opening is occupied by the spectral filter for Channel 4). As a result, the effective value of p_2 for the patch opening of Channel 4 is 9.12×10^{-4} .



	r_1	r_2	r_2'	r_3	S_{13}	S_{23}	S_{12}'
Ch 3 & 5	15.77	11.37	11.77	10.96	19.05	1.27	15.35
Ch 4	8.43	5.49	5.89	5.19	13.32	1.27	9.525

	F_{12}'	F_{31}	F_{32}	F_{33}'
Ch 3 & 5	0.248	0.361	0.921	0.6675
Ch 4	0.190	0.265	0.829	0.434

NOTE: F_{ij} = view factor from area i to j

	Housing Window	Radiator Window	Patch Opening
Ch 3 & 5	Zn Se	Zn Se with bandpass	Optical elements and gold baffle
Ch 4	Sapphire	Sapphire	Spectral filter

(Dimensions in millimeters)

Figure 5.4 Dimensions and Opening Materials for Optical Port

Moreover, the input to Channel 4 as well as to Channels 3 and 5 is now from the relay at +20°C, so that we have

$$\begin{aligned}\phi_{13} \text{ (Chs. 3 and 5)} &= 8.21 \times 10^{-3} \text{ W, and} \\ \phi_{13} \text{ (Ch. 4)} &= 6.9 \times 10^{-6} \text{ W.}\end{aligned}$$

The input to the patch from the inner window attached to the radiator is given by

$$\phi_{23} = \sigma T_w^4 \epsilon_2 F_{32} \gamma_3 A_3$$

The window temperature, T_w , is a nominal 9K above the radiator. For an inner window of $\text{Zn}^{\text{W}}\text{Se}$ and for greybody radiation at the window temperature, the window emissivity, ϵ_2 , is approximately 0.45 (Y.S. Touloukian and D. P. DeWitt, op. cit.) and the effective patch absorptivity is still 0.773 (Channels 3 and 5). For an inner window of sapphire, ϵ_2 , is about 0.5. The effective absorptivity, γ_3 , of the patch opening in Channel 4 was calculated from

$$\gamma_3 = \frac{\alpha_3}{1 - \rho_2(1 - \alpha_3) F_{33'}}$$

where α_3 is the actual absorptivity of the patch opening (spectral filter) and ρ_2 is the (specular) reflectance of the inner window, both for the window radiation. For a sapphire radiator window and a germanium patch opening, we have $\alpha_2 = 0.63$ and $\rho_2 = 0.5$, so that $\gamma_3 = 0.685$. The thermal loads on the patch from the radiator windows are therefore

$$\begin{aligned}\phi_{23} \text{ (Chs. 3 \& 5)} &= 6.852 \times 10^{-12} (T_r + 9\text{K})^4 \\ \phi_{23} \text{ (Ch. 4)} &= 1.362 \times 10^{-12} (T_r + 9\text{K})^4\end{aligned}$$

Thus, the total optical port loading on the radiator and patch are, respectively,

$$\begin{aligned}\phi_{\text{or}} &= 0.331 \text{ W, and} \\ \phi_{\text{or}} &= 8.21 \times 10^{-3} + 8.214 \times 10^{-12} (T_r + 9\text{K})^4 \text{ W.}\end{aligned}$$

5.5 OTM Cooler Thermal Tests

Chamber tests on the AVHRR/2 OTM radiant cooler were run in the period from February 28 to March 2, 1977. Two tests were run, one at a control point of 103.4K and a second at 108.3K. The results are listed in the first column of Table 5.6; the second column shows these measurements corrected to in-orbit operation under nominal conditions. The corrections are based on the analytical model of the radiant cooler (to be contained in the AVHRR/2 Technical Description), which predicted the temperatures listed in the third column.

We see that the cooler meets the specified requirement for a 10K margin at a 108K control point with about 1K to spare. To correct from chamber to nominal in-orbit conditions, we first used the measured temperatures to calculate an effective insulation factor for the multilayer blanket on the rear surface of the radiator. This was done by using the nominal thermal characteristics in the analytical model for everything but the blanket itself. The results are listed in the first column of Table 5.7; they show an average insulation factor of 51.5.

In retrospect, however, it is not fair to compare this value with that attained on the AVHRR/1. In particular, the insulation factor includes the net effect of heating the radiator windows, and in AVHRR/1 this effect is quite small. A nominal power of 0.050W is applied to each window; most of this is conducted into the radiator through the polyimide isolator. This input, however, is offset by radiant emission from the radiator optical port (chiefly from the cold trap back into the housing). We estimate the net input on the AVHRR/1 to amount to 0.020W. This corresponds to a radiator temperature change of 0.42K or an insulation factor change of about 2.3 or 4%. In the AVHRR/2, we have about the same input at the radiator optical port of Channels 3 and 5. However, the Channel 4 port is not an effective emitter and introduces a net load of approximately 0.044W into the first stage of cooling. If this is subtracted from the insulation input derived from the chamber tests, we find that the insulation factor increases to the values listed in the second column of Table 2 or to an average value of 58.0. This is less than the 65 achieved on recent models of the AVHRR/1, but it is nevertheless a very good value in view of the additional optical port and the resultant increase in the complexity of the multilayer blanket.

TABLE 5.6
AVHRR OTM Radiant Cooler THERMAL Performance
Chamber Test Analytical Model

	Measured	Corrected	Predicted
T_h	3.3°C	17.5°C	17.5°C
T_o	13°C	20°C*	20°C*
T_r	167.7K, 167.4K	171.0K, 170.7K	168.8K - 173.2K
Uncontrolled T_p	-- --	96.9K, 97.1K	95.4K - 97.1K
Controlled T_p	103.4K, 108.3K	105K	105K
Control Power	22.04mW, 41.04mW	29.4mW, 28.7mW	34.0mW - 28.7mW
Joule heat	1.46mW	3.5mW	3.5mW

* Except for Channel 4 input to radiator which is at 17.5°C.

T = temperature
h = cooler housing
o = optics
r = radiator
p = patch

TABLE 5.7
INSULATION FACTOR OF RADIATOR
(AVHRR/2 OTM)

<u>Test No.</u>	Insulation Factor S_i	
	<u>Uncorrected</u>	<u>Corrected to -/1 Condition</u>
1	50.7	57.0
2	52.3	59.0

Returning now to our approach to the calculation of nominal in-orbit performance from the chamber test results, we next used the analytical model with the experimentally determined insulation factor to predict the radiator temperature under nominal orbital conditions. As shown in Table 5.6, the result is approximately 171K, which is in the middle of the predicted range of about 169K to 173K.

We then used the analytical model to predict all the in-chamber thermal loads on the patch. This prediction includes the measured control power and calculated radiant input from the first stage produced by reflection off the imperfect cold space target. It is also based on the measured radiator temperature and the nominal thermal properties used in the patch analytical model. The predicted chamber heat load was then compared with the calculated power emitted at the measured patch temperature. We found that the emitted power exceeded the predicted inputs by an amount we term the excess input (ϕ_x). The value of ϕ_x varied from 2.07 mW at the 103.4K control point to 3.21 mW at the 108.3K point.

There are three potential sources of the excess heat load. The first is the inaccuracy contained in each measurement of temperature and power. The second is the inaccuracy in each term used in the analytical model; the prime suspect here is probably the optical port loading. And the third is the failure to attain a steady-state equilibrium in the cooler and its surroundings; in this case, the actual performance is better than that measured. In terms of temperature increments on the patch, the excess inputs correspond to 0.6K and 1.0K at 97K or 0.5K and 0.8K at 105K. Most of the increase (1.14 mW) in excess input between the two control points shows up in the control power. Thus the analytical model predicts that the control power should increase by 20.0 mW between 103.4K and 108.3K, whereas, the measured increase was 1.0 mW less (19.0 mW).

And finally, the calculated in-orbit radiator temperature was combined with the derived value of ϕ_x to correct the measured patch temperature to orbital conditions.^x The corrected values were based on the predicted in-orbit optical temperature (T_o in Table 5.6), the projected joule heat (3.5 mW; the 1.46 mW during the tests was dissipated in the temperature sensor), and the absence of a space target input.

6.0 MECHANICAL DESCRIPTION

The AVHRR/2 instrument, basically, is the same as the AVHRR/1 instrument with the exception of the 5th optical channel. The addition of the 5th optical channel required the following mechanical changes.

1. Redesign of relay optics to accommodate 5th channel.
2. Change patch to accommodate additional channel.
3. Slight change in radiator for the additional channel.
4. Addition of window and header in vacuum housing.
5. Baseplate modification to raise cooler.
6. Additional P.C. board and preamp module.
7. Slight size and weight increase.

The following paragraphs describe the changes required for the above seven items.

6.1 Relay Optics

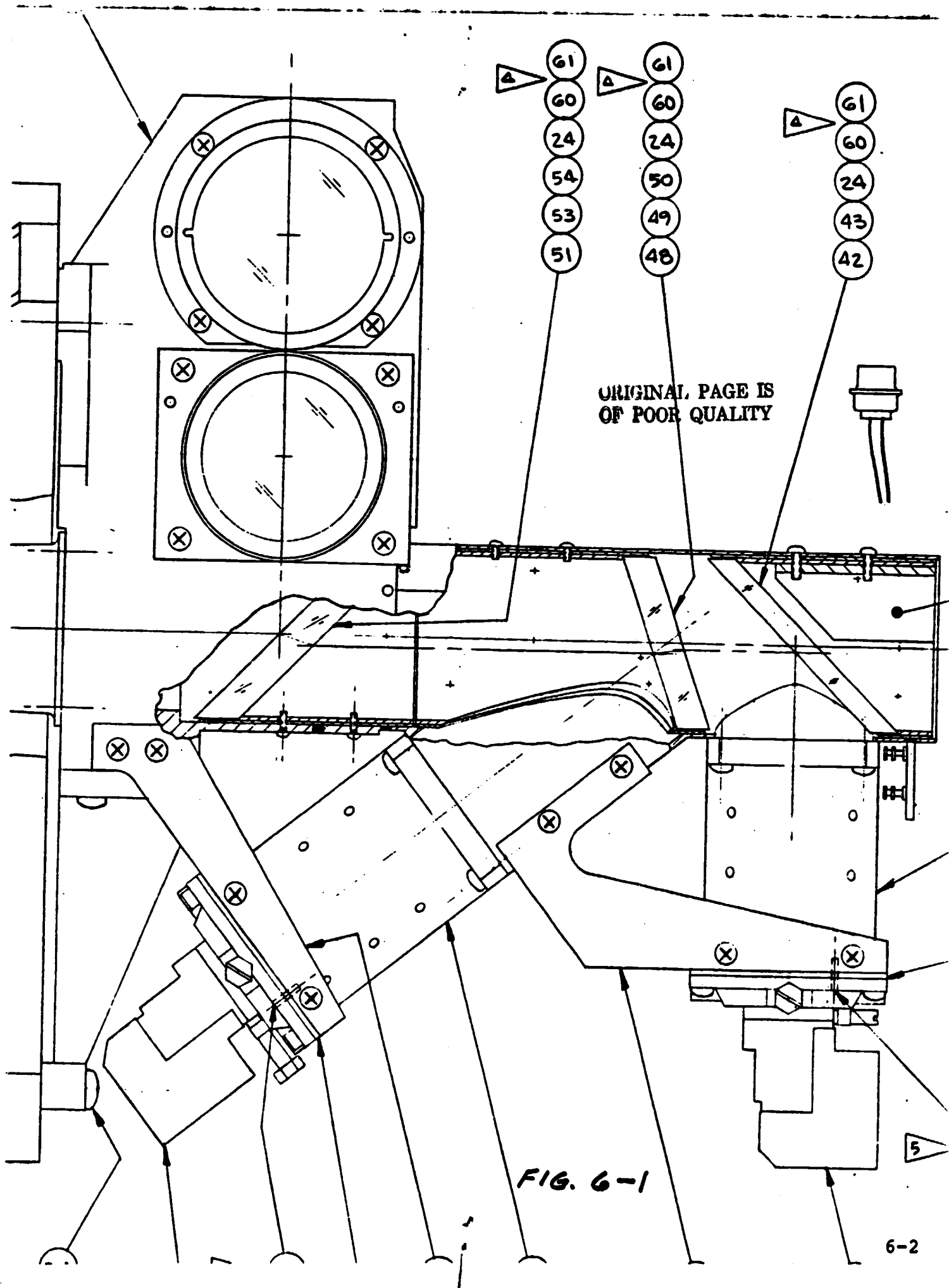
The relay optics for the AVHRR/2 has been changed to add another I.R. channel, and, in addition, the folding optical assemblies are being retained in a more positive manner.

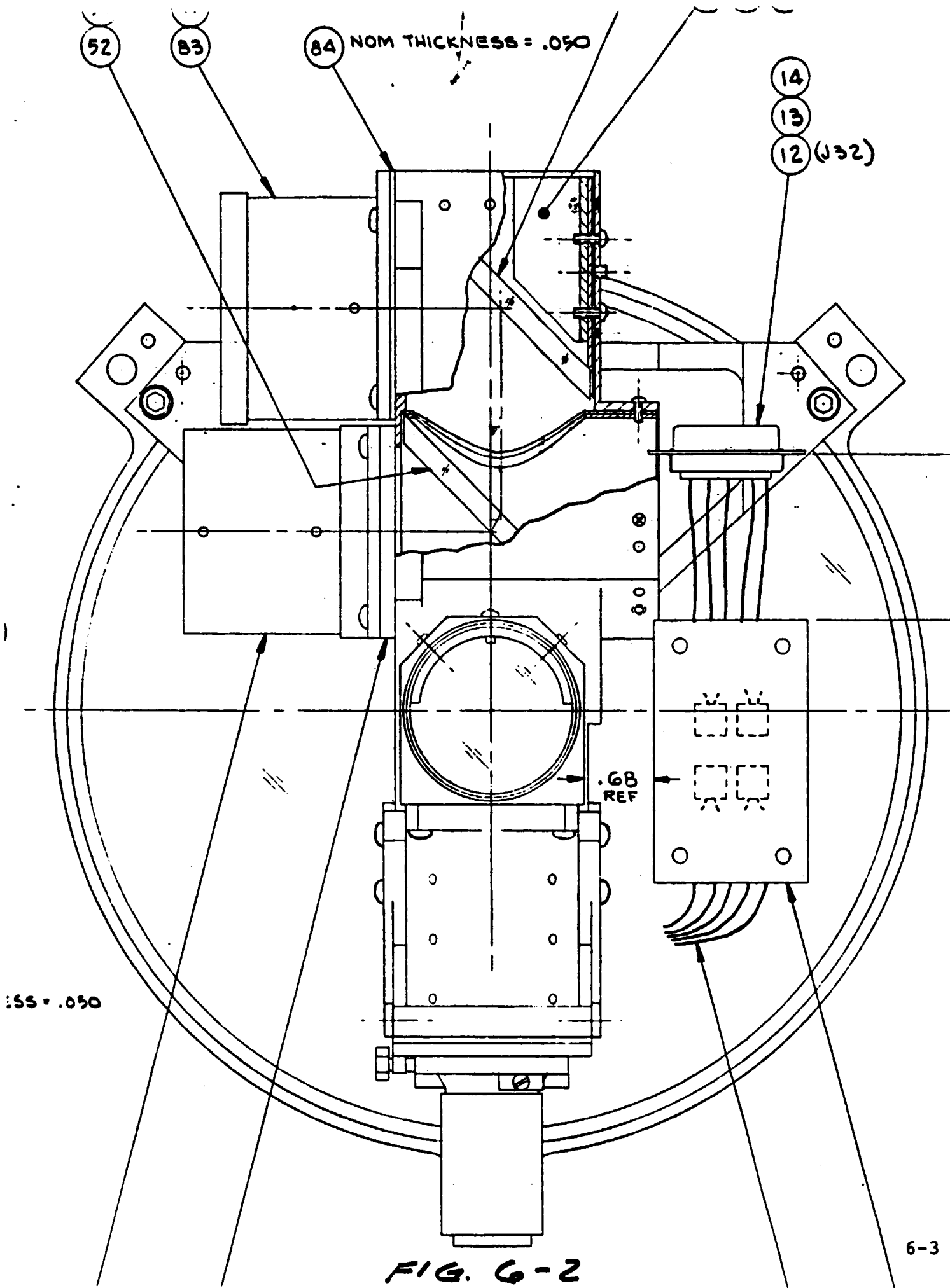
An additional I.R. focus lense was added directly above the existing I.R. focus lense which necessitated an increase in height of the relay optics housing of 1.94 inches (Figures 6-1 and 6-2).

The folding assemblies of the relay optics on the /1 design were retained in the optics housing by setscrews and the injection of RTV between the outer sleeve of the assembly and the relay optics housing. As a result of vibration testing, a clamp was added to the inside of the Channel 2 folding element to further restrain it during vibration (Figure 6-1). Structural adhesive was also applied around the periphery between the sleeve and the relay optics housing of Channel 2 folding mirror assembly and Channels 3 and 4 folding mirror assembly.

All of the above features were retained in the /2 design, and, in addition, a clamp, similar to the one used on Channel 2, has been added to Channel 3/5 lens assembly (Figure 6-2).

It was physically impossible to restrain the gold beam-splitter, neutral density and I.R. dichroic assemblies by the use of clamps, so two threaded holes have been added to the spacers of these assemblies and screws have been added to aid in alignment and retention of the assemblies (Figures 6-1 and 6-2.).





6.2 Patch

The patch configurations has changed in several ways as can be seen in Figure 6-3. On the /1 design, the detectors and dichroic mounted on a frame that in turn mounted in an enclosure that mounted to the patch (Figure 6-4). The /2 design incorporates the detector frame and the enclosure into one piece. The detector mounting frame has also been rotated 90° and an additional detector for the added channel has been placed on the frame. With the new /2 configuration, Channels 3 and 5 share the same focus lens (new focus lense that was added) and Channel 4 utilizes the other focus lense. The patch support rods have been shortened .7 inch, and have been moved apart to compensate for the added mass during vibration.

Four small solid polurethane snubbers have been added to the patch to aid in reducing the tranmissibility to the patch during vibration. The snubbers are ¼ inch diameter and are located in the four corners of the patch. When the earth shield door is closed, the snubbers are designed to rest against the door, thereby limiting the patch excursion during vibration. The patch has seen the highest Q levels during the Y axis of vibration, however, the snubbers have proven to be very effective in reducing these levels.

6.3 Radiator

Minimal changes were made to the radiator. An additional window was added for the fifth optical channel and one radiator support rod was moved to allow room for the increased detector frame size.

6.4 Vacuum Housing

The vacuum housing for the /2 design has also changed very little. In addition to the added window for the fifth optical channel, a removable header plate was added to the back surface of the housing to make the assembly and trouble shooting easier. The flange size of the vacuum housing remains the same as /1 and will mount to /1 bench cooler.

6.5 Baseplate

The /2 baseplate is basically the same as /1 with the exception of a few minor changes. One change adds a mounting base between the baseplate and the cooler. This baseplate adapter, as it is called, accomplishes two objectives. One, it raises the cooler assembly the requited height for proper alignment with the added optical channel, and secondly, it provides for easier alignment of the cooler with the optical channels. Another minor change was made to the in-flight black body calibration target area of the baseplate. This change was made to simplify the machining and assembly of the baseplate target area.

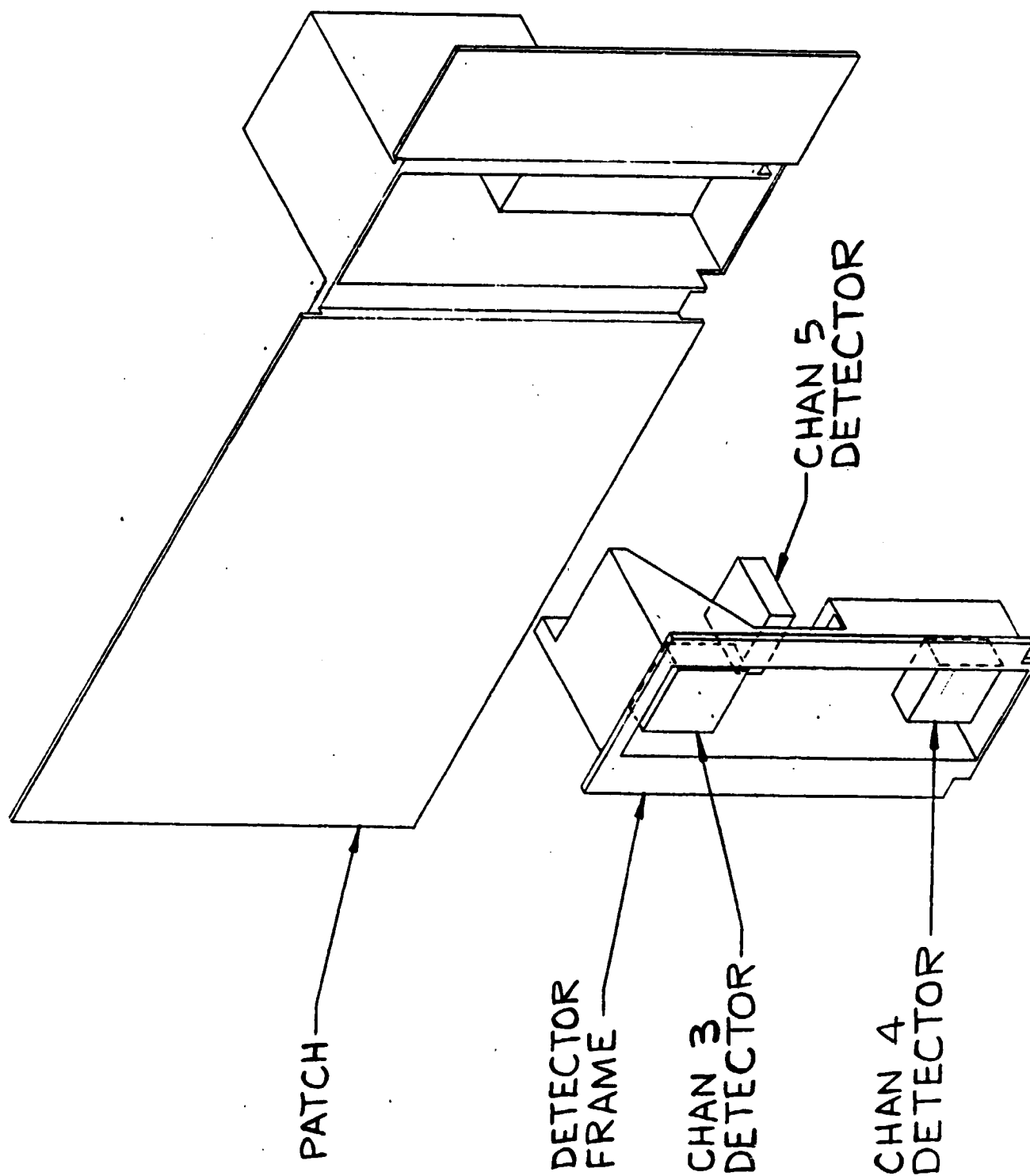
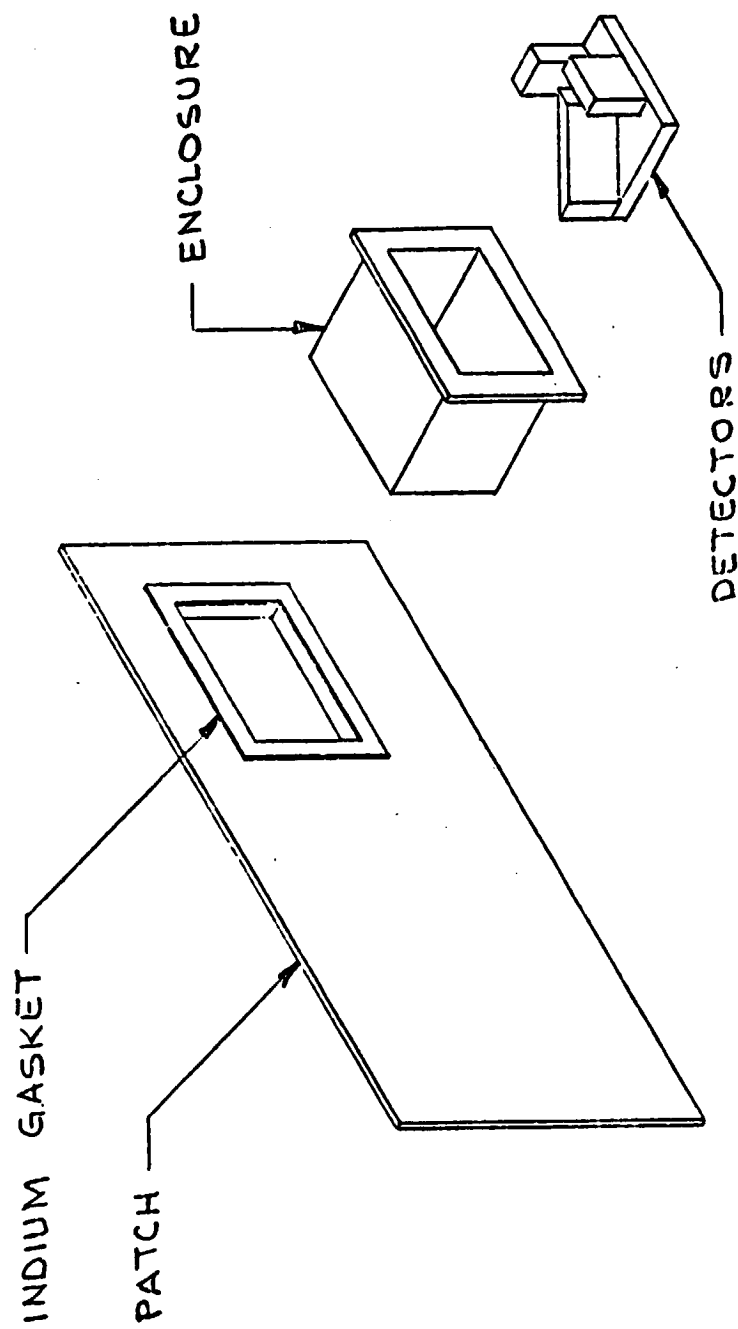


FIG. 6-3



1. PATCH DESIGN

FIG. 6-4

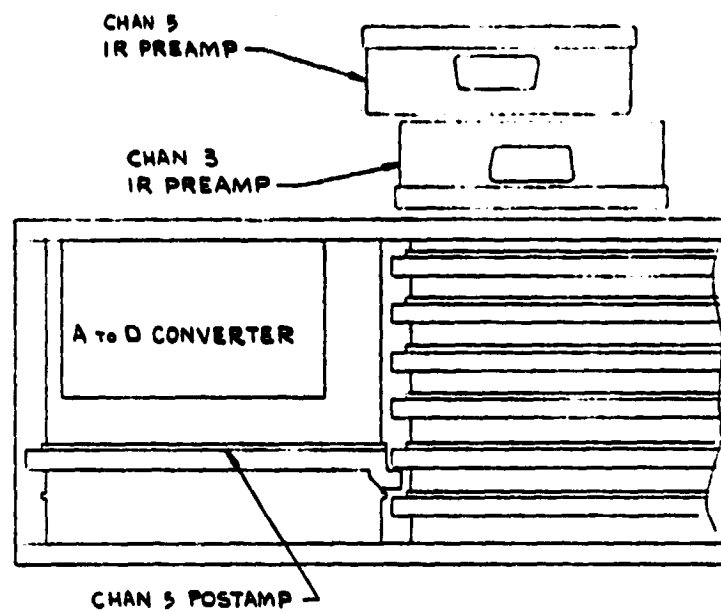
6.6 Electronics Module

The electronics module was extended approximately 1-3/8" in length to provide room for Channel 5 post amplifier p.c. board. Figure 6-5 shows the difference between the /1 and /2 designs. As can be seen in the figures, the A to D Converter was moved from the end wall of the electronics module to the side wall to make room for post amplifier board. Figure 6-5 also shows the location of the added Channel 5 pre-amplifier.

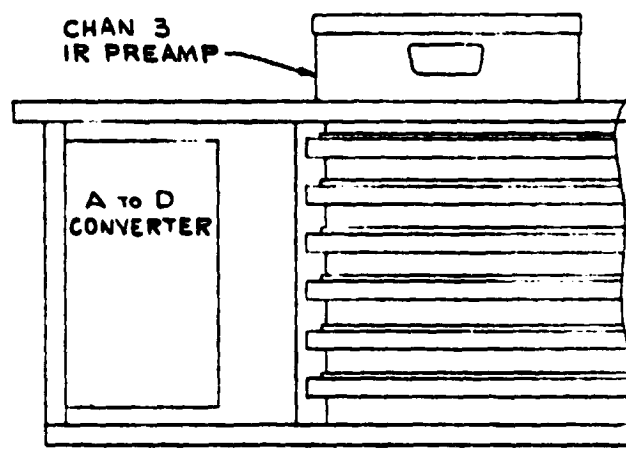
6.7 Size and Weight

The size of the AVHRS/2 is 30.25" x 11.19" x 14.31" without the Thermal blanket. The instrument weighs 63.31 lbs. with Thermal blanket installed.

The outline drawing of the instrument is shown in Figure 6-6.

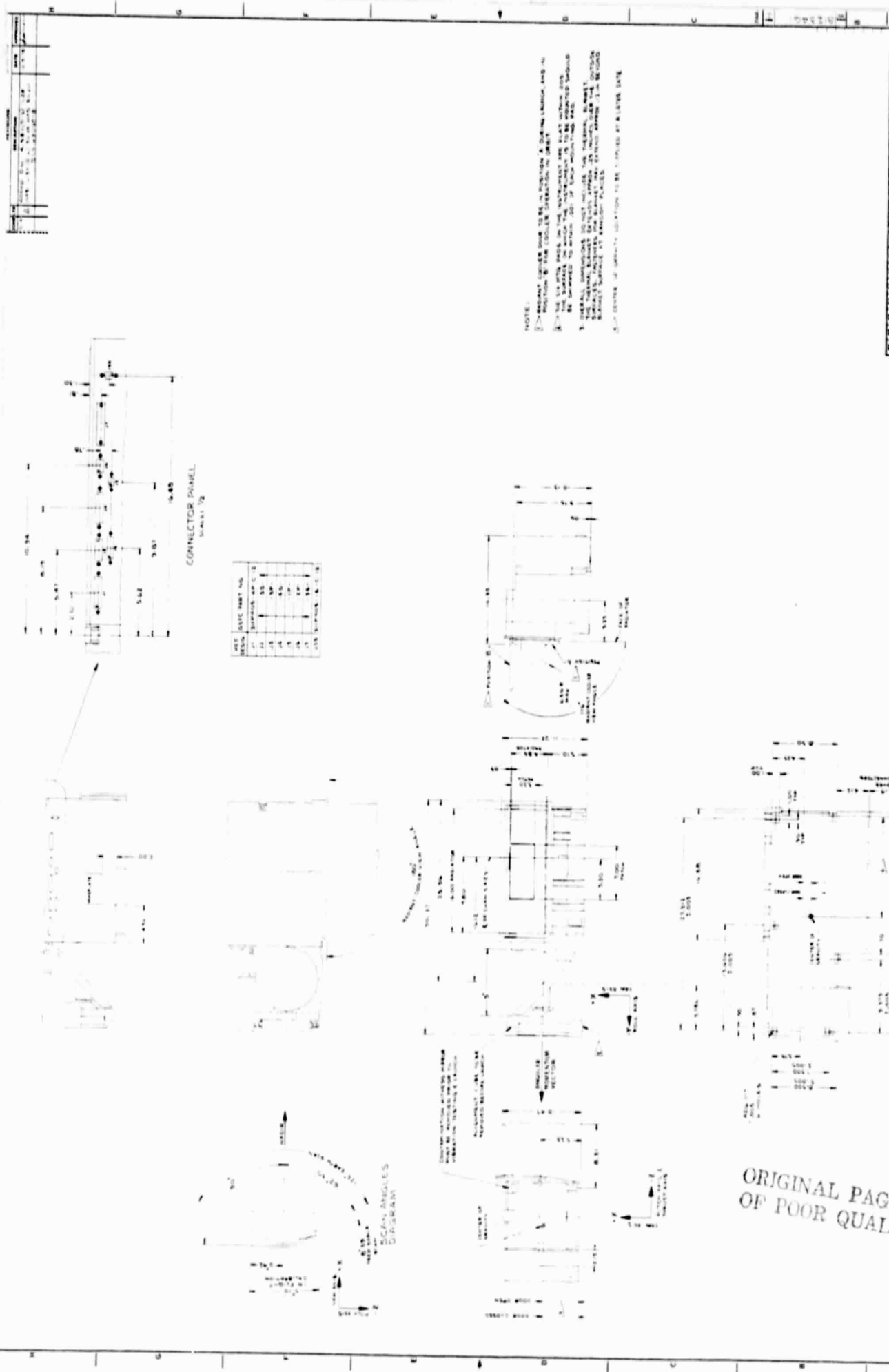


AVHRR / 2



AVHRR / 1

FIG. 6-5



NOTE:
 1. THESE WIRING DIAGRAMS ARE FOR INFORMATION ONLY. THEY ARE NOT TO BE USED FOR WIRING OR REPAIR WORK.
 2. THESE WIRING DIAGRAMS ARE FOR INFORMATION ONLY. THEY ARE NOT TO BE USED FOR WIRING OR REPAIR WORK.
 3. THESE WIRING DIAGRAMS ARE FOR INFORMATION ONLY. THEY ARE NOT TO BE USED FOR WIRING OR REPAIR WORK.
 4. THESE WIRING DIAGRAMS ARE FOR INFORMATION ONLY. THEY ARE NOT TO BE USED FOR WIRING OR REPAIR WORK.

OUTLINE DRAWING		AVHRR/Z INSTRUMENT	
DATE: 11/1/78		BY: 01234	
DRAWN BY: 01234		CHECKED BY: 01234	
APPROVED BY: 01234		DATE: 11/1/78	

FIGURE 6-6

ORIGINAL PAGE IS
 OF POOR QUALITY

7.0 ELECTRONICS

The AVHRR/1 design anticipated the 5 channel design so that minimal electrical changes are required. The major change to the electrical system is the addition of the circuits for the fifth data channel. This requires the addition of a new p.c. assembly for the Channel 5 Post Amplifier and an additional pre-amplifier which is identical to the Channel 3 pre-amplifier.

7.1 Channel 5 Post Amplifier

The schematic for the Channel 5 Post Amplifier is shown in Figure 7-1. The amplifier section is identical to the Channel 3 Post Amplifier. This board contains all the linear regulators and enabling circuits for Channel 5. It also contains the sample and hold circuits for the Channel 5 BB Temperature IR TM.

7.2 Command Relay No. 4

An additional relay and command verification circuits have been added for enabling Channel 5. The remaining circuits are the same as the AVHRR/1 Command Relay No. 3.

7.3 Patch Temperature and Control TM

Component value changes have been made for the patch and cooler temperature TM circuits to accommodate the differences in connecting lead resistance and secondary control temperature. Values were selected to give the same telemetry equations as those for AVHRR/1.

7.4 Scan Count and Decode

Gating was added to the logic signal for the Ramp Calibration Signal. The additional gating is for disabling Ramp Calibration from the test connector. This is done to remove the signal for such tests as registration and field of view instrument tests.

7.5 Worst Case and Stress Analysis

The following changes were made as a result of the worst case and stress analysis.

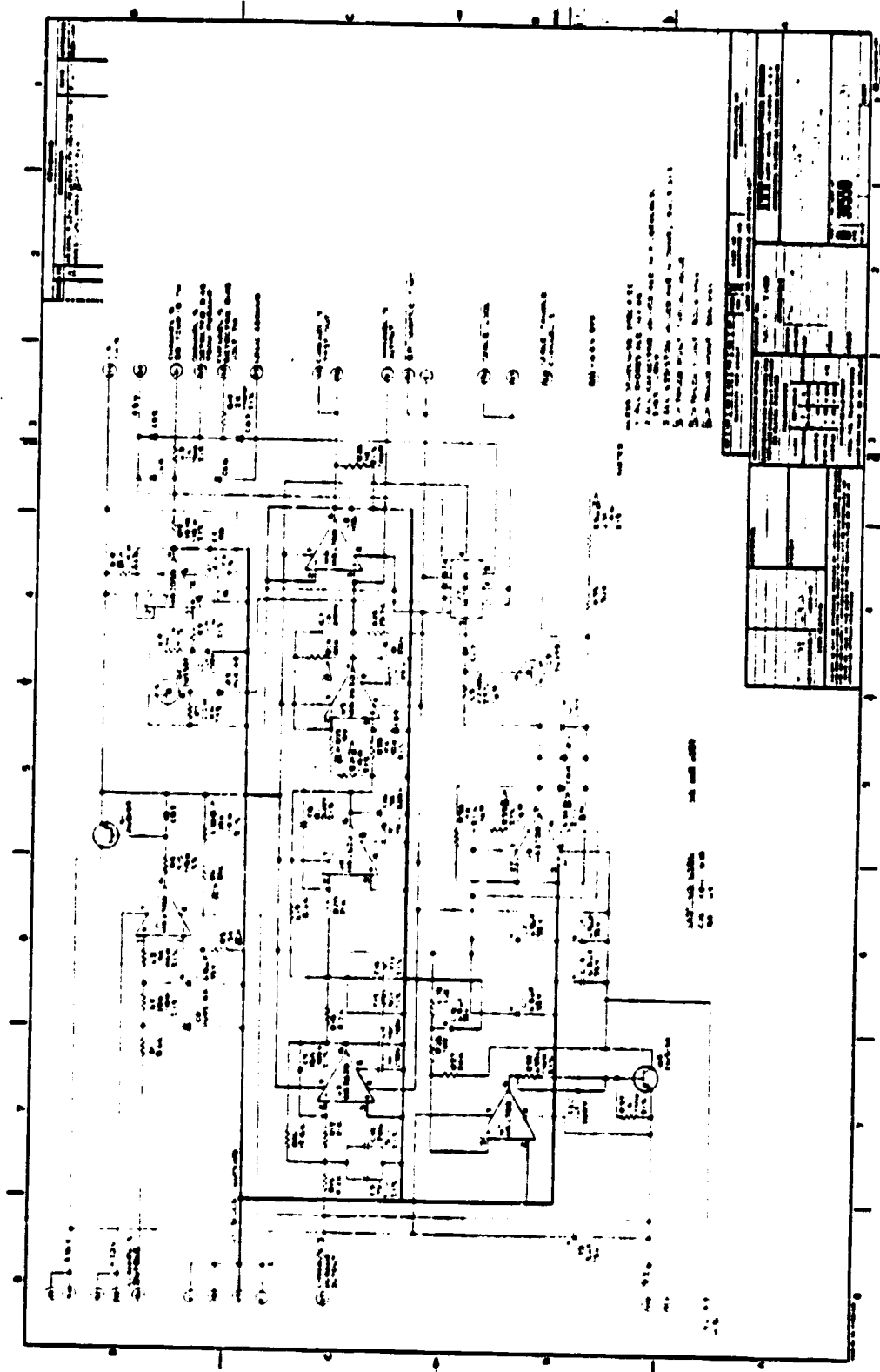
1) Multiplexer - Capacitor C11 was changed from 22 μ f 15 volts to 6.8 μ f 35 volts. Voltage stress now 0.294, rated 0.6.

2) Logic Regulator - Resistor R22 changed from 510 ohm to 470 ohms. Base drive for transistor Q9 in the 5 volt regulator circuit now meets worst case conditions.

3) +15 volt Regulator - Resistor R23 changed from 8.2K $\frac{1}{4}$ watt to 6.8K $\frac{1}{4}$ watt. Base drive for transistor Q6 in the -15V Electronics enable circuit now meets worst case conditions. Power stress on R23 now 0.342, rated 0.5.

[illegible]

FIGURE 7-1



7.6 Interface Connections

The complete list for the AVHRR/2 interface connectors is given in Table 7-1.

7.7 Printed Circuit Board Drawings

A listing of all applicable drawings for each of the AVHRR/2 printed circuit boards is given in Table 7-2.

7.8 Power Profile

The Power Profile for the AVHRR/2 is shown in Table 7-3.

TABLE 7-1

J1 COMMAND

<u>PIN NO.</u>	<u>FUNCTION</u>
1	Elec/Telemetry On
2	Elec/Telemetry Off
3	Motor/Telemetry On
4	Motor/Telemetry Off
5	Telemetry Not Locked On
6	Telemetry Locked On
7	Channel 1 Enable
8	Channel 1 Disable
9	Channel 2 Enable
10	Channel 2 Disable
11	Channel 3 Enable
12	Channel 3 Disable
13	Channel 4 Enable
14	Channel 4 Disable
15	Motor Low Power
16	Motor High Power
17	Patch Low
18	Patch High
19	
20	Patch Control Off
21	Patch Control On
22	Earth Shield Disable
23	Earth Shield Deploy
24	Cooler Heat Off
25	Cooler Heat On
26	Voltage Calibrate Off
27	Voltage Calibrate On

J1 COMMAND (Continued)

<u>PIN NO.</u>	<u>FUNCTION</u>
28	CHANNEL 5 ENABLE
29	CHANNEL 5 DISABLE
37	Chassis Ground

J2 DIGITAL TM

<u>PIN NO.</u>	<u>FUNCTION</u>
1	Earth Shield Status
2	Patch Control Status
3	Patch Mode Status
4	Motor Mode Status
5	Voltage Calibrate Status
6	Cooler Heat Status
7	Electronics/Telemetry Status
8	Motor/Telemetry Status
9	Telemetry Lock Status
10	Channel 1 Status
11	Channel 2 Status
12	Channel 3 Status
13	Channel 4 Status
14	CHANNEL 5 STATUS
25	Chassis Ground

J3 POWER

<u>PIN NO.</u>	<u>FUNCTION</u>
1	+28V Buss
2	+28V Buss
3	+28V Buss (Motor)
4	+28V Buss (Motor)
5	Power Ground
6	Power Ground
7	AC 28V Return
8	AC 28V Return
9	+10V Buss
10	+10V Buss
11	+5V Buss
12	+5V Buss
13	Interface Power Ground
14	Interface Power Ground
15	Signal Ground
16	Signal Ground
17	Chassis Ground
18	Chassis Ground

J4 ANALOG TM

<u>PIN NO.</u>	<u>FUNCTION</u>
1	Radiator Temp. TM
2	Patch Power TM
3	Patch Temp TM Low Range
4	Patch Temp TM Ext Range
5	Black Body #1 TM
6	Black Body #2 TM
7	Black Body #3 TM
8	Black Body #4 TM
9	Motor Current TM
10	Elect. Current TM
11	Earth Shield Position TM
12	Electronics Temp. TM
13	Base Plate Temp. TM
14	A/D Conv. Temp. TM
15	Motor Hsg. Temp TM
16	Cooler Hsg. Temp. TM
17	Detector Bias Volt Ch. 3 TM
18	DETECTOR BIAS VOLT CH 5 TM
19	BB Temp. IR Ch. 3 TM
20	BB Temp. IR Ch. 4 TM
21	Offset Voltage TM
22	BB TEMP IR CH 5 TM
37	Chassis Ground

J5 CLOCK

<u>PIN NO.</u>	<u>FUNCTION</u>
1	Clock - Ref
2	Clock
3	Clock Shield
4	Chassis Ground

J6 DATA PROCESSOR

<u>PIN NO.</u>	<u>FUNCTION</u>
1	2^9 MIRP Data
2	2^8 MIRP Data
3	2^7 MIRP Data
4	2^6 MIRP Data
5	2^5 MIRP Data
6	2^4 MIRP Data
7	2^3 MIRP Data
8	2^2 MIRP Data
9	2^1 MIRP Data
10	2^0 MIRP Data
11	Chassis Ground
12	Sample Pulse From MIRP
13	Chassis Ground
14	Sync Pulse
15	Chassis Ground

J7 TEST

<u>PIN NO.</u>	<u>FUNCTION</u>
1	Test - Pick-up loss sim.
2	Ramp Cal. 3 level
3	Ch. 3 Test
4	Ch. 4 Test
5	Ch. 1 Test
6	Ch. 2 Test
7	REf. V Test Point
8	Pick-up #1 Test
9	Pick-up #2 Test
10	-15V Test
11	+15V Test
12	Clock Rcvr Test
13	Solenoid +28
14	Solenoid +28
15	+5V Test
16	SIGNAL GROUND
17	Sync Pulse
18	CHANNEL 5 TEST
19	RAMP CAL INHIBIT
50	Chassis Ground

J33 - PULSE LOAD HEATER

<u>PIN NO.</u>	<u>FUNCTION</u>
1	Pulse Load Heater
2	Pulse Load Heater Ret.
3	Temp. Control Sensor
4	Temp. Control Sensor
5	
6	
7	Chassis Ground
8	
9	

Table 7 -2 AVHRR/2 CIRCUIT BOARD DRAWING NUMBERS

CIRCUIT NAME	SCHEMATIC	BOARD #	ASSEMBLY DRAWING	ASSEMBLY PROCEDURE	TEST PROCEDURE
POWER CONV. & SW. REG.	8007970	8007971	8007972-G1	8008230	8008279
LOGICS REGULATORS	8123373	8007976	8007977-G2	8123378	8123372
+15V REGULATORS	8123374	8123375	8007982-G2	8123376	8123377
MOTOR SW. REG.	8007944	8007945	8007946-G1	8008233	8008297
COMMAND RELAY #1	8008800	8008801	8008802-G1	8008234	8008280
COMMAND RELAY #2	8008794	8008795	8008796-G1	8008235	8008281
COMMAND RELAY #4	8122573	8008795	8008796-G3	8122574	8122575
PATCH TEMP CONT. & T/M	8122569	8008121	8008122-G2	8122570	8122571
T/M BOARD #2	8008127	8008128	8008129-G1	8008237	8008291
MOTOR LOGICS	8008045	8008046	8008047-G1	8008238	8008283
SCAN COUNT & DEC.	8123386	8123387	8008051-G2	8123388	8123309
INTERFACE LOGICS #1	8009206	8009207	8009208-G1	8008240	8008293
INTERFACE LOGICS #2	8009209	8009210	8009211-G1	8009225	8009228
RAMP CAL. GEN.	8007963	8007964	8007965-G1	8008241	8008285
AUX SCAN LOGICS	8008052	8008053	8008054-G1	8008242	8008286
CH. 3 PREAMP	8008101	8008102	8008103-G1	8008243	8008294
CH. 4 PREAMP	8009217	8009218	8009219-G1	8009226	8009229
IR POST AMP	8008078	8008079	8008080-G1	8008244	8008288
DAYLIGHT PREAMP	8008130	8008131	8008132-G1	8008245	8008295
DAYLIGHT POST AMP	8008096	8008097	8008098-G1	8008246	8008289
MULTIPLEXER	8123379	8008134	8008135-G2	8123380	8123381
MOTOR POWER SUPPLY	8007941	8007942	8007943-G1	8008248	8008296
BLACK BODY MUX	8008250	8008251	8008252-G1	8008249	8008287
CHANNEL 5 POST AMP	8122091	8122092	8122093-G1	8123416	8123417

POWER PROFILE

FUNCTION	POWER	NORMAL OPERATION	TELEMETRY ONLY	MOTOR ON	COOLER HEATER	INSTRUMENT OFF
ANALOG TELEMETRY & MOTOR LOGICS	3.22W	X	X	X	X	
A-D & ELECTRONICS **	12.94W	X				
SCAN MOTOR HIGH	4.84W	X		X		
SCAN MOTOR LOW	3.98W			X		
CHANNEL 1	.67W	X				
CHANNEL 2	.89W	X				
CHANNEL 3	1.4W	X				
CHANNEL 4	.95W	X				
CHANNEL 5	1.8W	X				
COOLER HEATER	21.2W				X	
COOLER COVER DEPLOY	56.9W*					
STANDBY HEATER	22.8W**					X
		26.71W	3.22W	7.20 or 8.06	24.75W	22.8W**

* Required only once for a period of approximately 1 sec.

** Supplied from TCE - not from +28V buss.

TABLE 7 - 3

8.0 THERMAL MODEL

The in-orbit nodal temperatures of the AVHRR/2 are given in Tables 8-1 thru 8-4 which follow.

The Thermal Interface Drawing for AVHRR/2 is given in Figure 8-5.

AVHRR/2 NODAL TEMPERATURES (°C)

NOMINAL CASE

ORBIT

28°

68°

0°

NODE DESCRIPTION

1	PWF CONV
2	VOLT REG
3	RELAY 23
4	PATCH TM
5	TM # 2
6	AUX SCAN
7	SCAN CTX
8	MTR L JGI
9	BLK BODY
10	AMPC H3E4
11	POSTAL E2
12	RAIP CAL
13	LOGIC #1
14	LOGIC #2
15	MULTPLX
16	POSTACH2
17	P AMP 3E5
18	A/O CONV
19	CH 1 DET
20	CH 2 DET
21	ELEC A-3
22	ELEC SUN
23	CONNECTJ
24	HARNESS
25	ELEC-VEL
26	ELPART 1
27	ELPART 2
28	ELPART 3
29	RADIARRAD
30	P-AMP 4
31	ESHIELD S
32	ESHIELD I
33	WING +V
34	WING -V
35	NOT USED
36	SCAN AUT
37	SCAN HSG
38	RAD ELEC
39	SCAN PS
40	SCAN M F
41	SCAN I B
42	CAVITY S
43	CAVITY AS
44	BASE CAV
45	CAL TGTL
46	CAL TGTS
47	BULK TEL
48	TELE
49	BULK GEN
50	BASE TEL
51	BASE OPT
52	COCL HSG
53	TFL OPT I
54	CH 1 REL
55	CH 2 REL
56	END -VEL
57	EL COVER
58	LW RELAY
59	INS +VEL
60	INS ASUN
61	INS -VEL
62	INS SUN
63	INS RAD
64	SPACE

1	33.97	33.83	33.75
2	41.16	41.04	40.98
3	28.19	28.03	27.96
4	26.55	26.41	26.44
5	27.92	27.87	27.92
6	30.24	30.23	30.28
7	29.14	29.14	29.20
8	30.41	30.40	30.47
9	26.45	26.41	26.48
10	35.68	35.55	35.58
11	37.54	37.49	37.53
12	24.03	24.01	24.06
13	30.70	30.69	30.75
14	31.11	31.09	31.16
15	32.45	32.91	32.48
16	26.96	26.57	26.52
17	28.06	27.48	27.33
18	25.65	24.86	24.69
19	27.43	22.85	17.00
20	27.44	22.90	16.94
21	18.75	17.97	17.83
22	19.54	19.22	19.33
23	26.96	27.55	27.69
24	19.23	21.09	21.44
25	17.84	17.71	17.70
26	21.06	20.61	20.61
27	20.97	20.51	20.53
28	20.48	19.99	20.00
29	18.00	16.97	16.70
30	27.10	25.76	25.01
31	-77.88	-75.96	-81.33
32	-33.79	-31.50	-39.52
33	-75.72	-69.47	-83.07
34	-83.97	-74.83	-89.83
35	18.01	16.98	16.71
36	20.79	15.20	19.89
37	20.26	14.76	16.28
38	18.15	17.89	17.66
39	19.17	14.11	14.43
40	26.68	15.60	27.34
41	26.68	15.60	27.33
42	18.33	14.08	14.73
43	17.58	13.25	14.14
44	17.77	13.34	14.32
45	17.72	13.08	14.04
46	18.11	13.15	14.54
47	16.34	14.28	14.42
48	32.02	22.06	7.50
49	17.20	16.25	15.90
50	16.36	15.17	15.07
51	15.73	15.37	15.24
52	17.33	15.99	15.24
53	25.70	20.90	14.57
54	25.91	21.17	15.12
55	26.02	21.30	15.09
56	17.75	15.93	15.54
57	7.91	9.23	10.11
58	25.43	20.79	14.70
59	-25.16	-9.70	-67.68
60	-99.12	-94.13	-102.71
61	-44.32	-43.81	-56.01
62	41.21	-8.78	44.47
63	-10.89	-11.85	-20.44
64	-269.44	-269.44	-269.44

LOUVER EMISSIVITY = .4190 .2566 .2325

TABLE 8-1

AVHRR/2 NODAL TEMPERATURES (°C)
WORST CASE HOT

ORBIT

28°

68°

0°

NODE	DESCRIPTION	28°	68°	0°
1	PWR CONV	34.14	34.05	33.97
2	VOIT REG	41.32	41.25	41.18
3	RELAY123	28.38	28.26	28.18
4	PATCH TM	26.64	26.58	26.62
5	TM # 2	28.00	28.03	28.09
6	AUX SCAN	30.31	30.38	30.44
7	SCAN CTR	29.21	29.29	29.36
8	MTR LOGI	30.48	30.55	30.62
9	BLK BODY	26.53	26.57	26.65
10	AMPCH364	35.77	35.71	35.75
11	POSTA162	37.61	37.63	37.69
12	RAMP CAL	34.10	34.16	34.22
13	LOGIC #1	30.77	30.84	30.91
14	LOGIC #2	31.18	31.24	31.32
15	MULTPLX	33.03	33.06	33.14
16	POSTACH5	27.10	26.77	26.75
17	P AMP365	28.21	27.67	27.60
18	A/D CONV	25.87	25.10	25.00
19	CH 1 DET	28.25	23.37	17.55
20	CH 2 DET	28.24	23.41	17.47
21	ELEC A-S	18.98	18.21	18.14
22	ELEC SUN	19.68	19.46	19.55
23	CONNECTO	26.91	27.60	27.74
24	HARNESS	18.92	20.92	21.25
25	ELEC-VFI	17.97	17.92	17.95
26	ELPART 1	21.23	20.84	20.86
27	ELPART 2	21.12	20.74	20.77
28	ELPART 3	20.65	20.23	20.25
29	NADIRRAD	18.26	17.26	17.08
30	P-AMP 4	27.37	26.00	25.34
31	ESHIELDS	-71.07	-68.59	-76.00
32	ESHIELDI	-29.98	-27.19	-37.77
33	WING +V	-71.25	-63.51	-81.14
34	WING -V	-80.06	-68.60	-87.97
35	NOT USED	18.27	17.27	17.09
36	SCAN MOT	22.00	15.91	18.15
37	SCANMHSG	21.42	15.46	17.50
38	RAD ELEC	18.49	18.24	17.95
39	SCAN PS	20.03	14.77	15.39
40	SCAN M F	29.30	16.70	30.46
41	SCAN M B	29.30	16.70	30.45
42	CAVITY S	19.09	14.63	15.54
43	CAVITYAS	18.40	13.82	14.99
44	BASE CAV	18.53	13.85	15.10
45	CAL TGTI	18.48	13.59	14.83
46	CAL TGTS	18.89	13.67	15.33
47	BULK TEL	17.33	14.66	14.96
48	TELE	33.65	22.94	8.21
49	BULK CFN	17.42	16.48	16.23
50	BASE TEL	16.60	15.40	15.42
51	BASE OPT	15.82	15.51	15.47
52	COOL HSG	17.60	16.23	15.57
53	TEL OPTI	26.55	21.43	15.11
54	CH 1 REL	26.76	21.71	15.68
55	CH 2 REL	26.86	21.83	15.63
56	END -VEL	18.00	17.22	16.93
57	EL COVER	2.86	8.44	9.26
58	LW RELAY	26.25	21.31	15.24
59	INS +VEL	-9.07	-6.11	-70.46
60	INS ASUN	-101.44	-95.73	-105.65
61	INS -VEL	-51.38	-43.55	-57.26
62	INS SUN	46.92	-5.30	50.54
63	INS NAD	-14.88	-9.09	-24.58
64	SPACE	-269.44	-269.44	-269.44

LOUVER
EMISSIVITY = .4568 .2839 .2609

TABLE 8-2

AVHRR/2 NODAL TEMPERATURES (°C)
WORST CASE COLD

NODE	DESCRIPTION	ORBIT		
		28°	68°	0°
1	PWR CONV	33.69	33.87	33.85
2	VOLT REG	40.89	41.08	41.06
3	RELAY 123	27.89	28.05	28.04
4	PATCH T1	26.33	26.56	26.59
5	TM # 2	27.73	28.05	28.10
6	AUX SCAN	30.06	30.42	30.48
7	SCAN CTR	28.96	29.33	29.40
8	MTR LOGI	30.23	30.59	30.66
9	BLK BODY	26.26	26.58	26.66
10	AMPC H354	35.48	35.69	35.72
11	POSTA 162	37.36	37.65	37.70
12	RAMP CAL	33.85	34.19	34.25
13	LOGIC #1	30.52	30.88	30.95
14	LOGIC #2	30.93	31.28	31.35
15	MULTPLX	32.76	33.08	33.15
16	POSTACH5	26.67	26.60	26.57
17	P AMP 165	27.75	27.47	27.32
18	A/D CONV	25.26	24.76	24.61
19	CH 1 DET	26.45	21.59	16.39
20	CH 2 DET	26.48	21.65	16.36
21	ELEC A-S	18.36	17.86	17.75
22	ELEC SUN	19.23	19.26	19.41
23	CONNECTO	26.97	28.00	28.12
24	HARNESS	19.66	22.11	22.39
25	ELEC-VEL	17.53	17.76	17.75
26	ELPART 1	20.74	20.61	20.64
27	ELPART 2	20.64	20.52	20.56
28	ELPART 3	20.15	19.99	20.01
29	NADIR RAD	17.50	16.73	16.48
30	P-AMP 4	26.66	25.54	24.89
31	ESHIELDS	-22.34	-21.31	-34.87
32	ESHIELDI	-41.71	-40.65	-45.79
33	WING +V	-82.53	-79.00	-37.30
34	WING -V	-90.20	-84.61	-34.34
35	NOT USED	17.51	16.74	16.49
36	SCAN MOT	19.00	13.65	15.06
37	SCAN HSG	18.52	13.25	14.54
38	RAD ELEC	17.69	17.75	17.62
39	SCAN PS	17.72	12.71	13.11
40	SCAN M F	22.59	12.52	22.38
41	SCAN M B	22.59	12.52	22.38
42	CAVITY S	17.13	12.99	13.68
43	CAVITY AS	16.31	12.17	13.03
44	BASE CAV	16.61	12.33	13.31
45	CAL IGTL	16.53	12.02	13.01
46	CAL TGTS	16.92	12.10	13.50
47	BULK TEL	15.07	13.72	13.89
48	TELE	30.35	19.31	6.40
49	BULK GEN	16.81	16.11	15.80
50	BASE TEL	15.94	15.01	14.93
51	BASE OPT	15.51	15.46	15.32
52	COOL HSG	16.89	15.77	15.12
53	TEL OPTI	24.70	19.58	13.95
54	CH 1 REL	24.91	19.88	14.49
55	CH 2 REL	25.04	20.01	14.48
56	END -VEL	17.25	15.69	16.33
57	EL COVER	5.42	11.81	12.45
58	LW RELAY	24.45	19.51	14.10
59	INS +VEL	-27.65	-17.87	-34.89
60	INS ASUN	-95.75	-92.33	-98.78
61	INS -VEL	-45.75	-43.46	-56.10
62	INS SUN	34.56	-17.74	37.70
63	INS NAD	-16.69	-19.83	-31.84
64	SPACE	-269.44	-269.44	-269.44

LOUVER
EMISSIONITY = .3625 .1894 .1732

TABLE 8-3

AVHRR/2 NODAL TEMPERATURES (°C)
WORST CASE COLD (Power Off)

ORBIT

		0°	68°
NODE	DESCRIPTION		
1	PWR CONV	7.54	10.95
2	VOLT REG	7.43	10.83
3	RELAY 123	7.41	10.81
4	PATCH TM	-8.31	11.72
5	TM # 2	8.13	11.52
6	AUX SCAN	8.06	11.44
7	SCAN CTR	8.03	11.41
8	MTR LOGI	8.02	11.39
9	BLK BODY	8.02	11.38
10	AMPCH3&4	8.34	11.75
11	POSTAL&2	8.16	11.55
12	RAMP CAL	-8.09	11.47
13	LOGIC #1	8.06	11.44
14	LOGIC #2	8.05	11.42
15	MULTPLX	8.04	11.40
16	POSTACH5	8.70	12.16
17	P AMP3&5	11.04	14.62
18	A/D CONV	9.55	13.10
19	CH 1 DET	6.67	15.23
20	CH 2 DET	6.59	15.29
21	ELEC A-S	9.61	13.13
22	ELEC SUN	8.02	11.29
23	CONNECTO	7.29	10.64
24	HARNESS	5.86	9.14
25	ELEC-VEL	8.08	11.52
26	ELPART 1	8.56	11.94
27	ELPART 2	8.62	12.00
28	ELPART 3	8.69	12.08
29	NADIRRAD	9.51	13.14
30	P-AMP 4	10.34	14.33
31	ESHIELDS	-84.94	-81.31
32	ESHIELDI	-45.83	-40.65
33	WING +V	-87.85	-79.01
34	WING -V	-94.40	-84.61
35	NOT USED	9.51	13.14
36	SCAN MOT	13.06	14.90
37	SCANMHSG	12.28	14.22
38	RAD ELEC	6.40	9.34
39	SCAN PS	9.09	11.83
40	SCAN M F	19.32	13.52
41	SCAN M B	19.31	13.53
42	CAVITY S	9.40	11.97
43	CAVITYAS	9.06	11.44
44	BASE CAV	9.30	11.58
45	CAL TGTL	9.02	11.23
46	CAL TGTS	9.47	11.36
47	BULK TEL	8.86	11.92
48	TELE	1.55	17.56
49	BULK GEN	10.38	14.11
50	BASE TEL	10.06	13.54
51	BASE JPT	12.40	16.01
52	COOL HSG	10.34	14.38
53	TEL OPTI	6.37	15.37
54	CH 1 REL	6.55	15.32
55	CH 2 REL	6.44	15.34
56	END -VEL	9.92	13.53
57	EL COVER	2.32	5.47
58	LW RELAY	6.49	15.29
59	INS +VEL	-65.62	-17.34
60	INS ASUN	-99.37	-92.40
61	INS -VEL	-57.56	-47.10
62	INS SUN	30.67	-18.10
63	INS NAD	-33.10	-19.94
64	SPACE	-269.44	-269.44

TABLE 8-4

LOUVER = .1500 .1500

EMISSIONITY

Heater Pwr. (.94 of Nominal) = 23.5 watts



9.0 TEST AND CALIBRATION DATA

The test report for the Optical Test Model and a resume of the test results for the Protoflight Model are given on the following pages.

For detailed test results and calibration data, refer to

AVHRR/2 Test Report For Protoflight Model

Alignment and Calibration Data Book,
AVHRR/2 Protoflight Model

ADVANCED VERY HIGH RESOLUTION RADIOMETER

MOD 2

TEST REPORT

AVHRR/2

OPTICAL TEST MODEL

Prepared by

ITT AEROSPACE/OPTICAL DIVISION
FORT WAYNE, IN 46803

NATIONAL AERONAUTICS AND SPACE ADMINISTRATION
GODDARD SPACE FLIGHT CENTER
GREENBELT, MARYLAND 20771

CONTRACT NAS5-23400

1.0 INTRODUCTION

The Optical Test Model (OTM) was constructed and tested to prove structural integrity and performance of the redesigned relay optics and the radiant cooler, these being modifications of the designs used on AVHRR/1.

The OTM consisted of elements of the AVHRR/1 Breadboard and Mechanical/Structural Models (BBM & MSM) in conjunction with the redesigned optics and cooler, the resulting assembly being nearly identical structurally to the design to be used on the Protoflight Model. Specifically the OTM consisted of

- BBM telescope with new relay optics.
- New cooler
- MSM electronics module
- MSM scanner
- MSM baseplate (modified) with new brackets and covers.

2.0 OTM TEST PROGRAM

Figure 2-1 shows the tests which were performed on the OTM. Procedures followed were those utilized for AVHRR/1. Vibration levels were as specified for qualification by the AVHRR/2 instrument specification GSFC-S-726-5.

3.0 TEST RESULTS

The pages which follow give the results of the tests performed as presented at the AVHRR/2 MDR. It will be seen that the goals for the OTM have been achieved.

OTM TEST PROGRAM

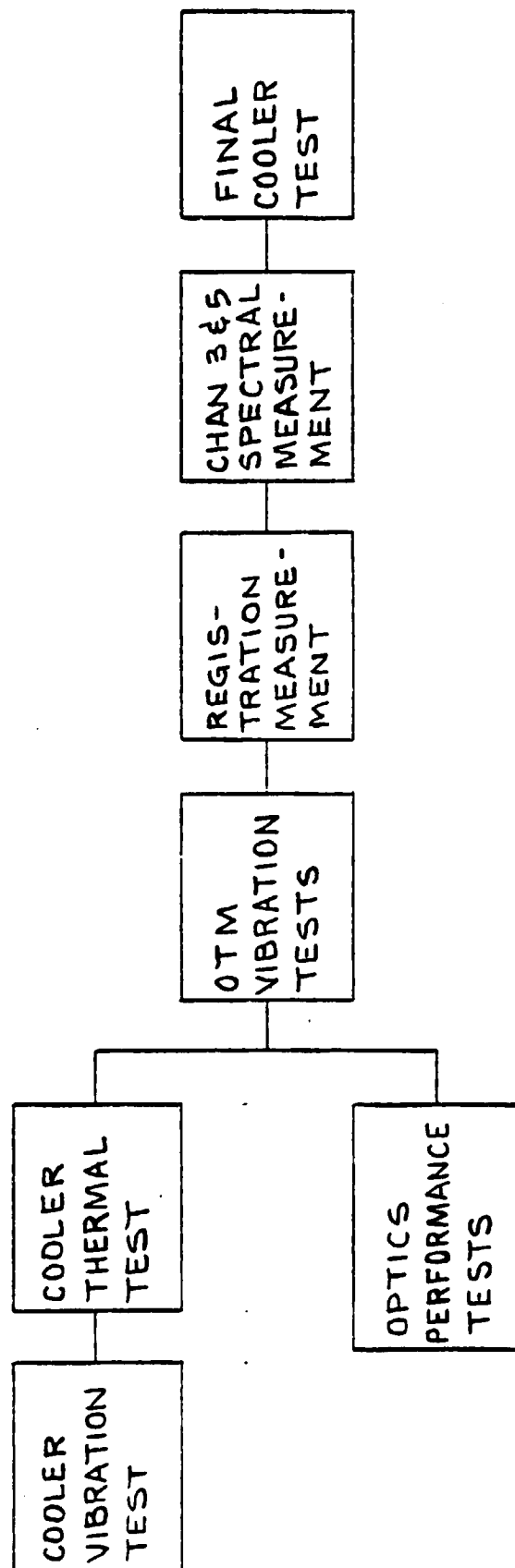
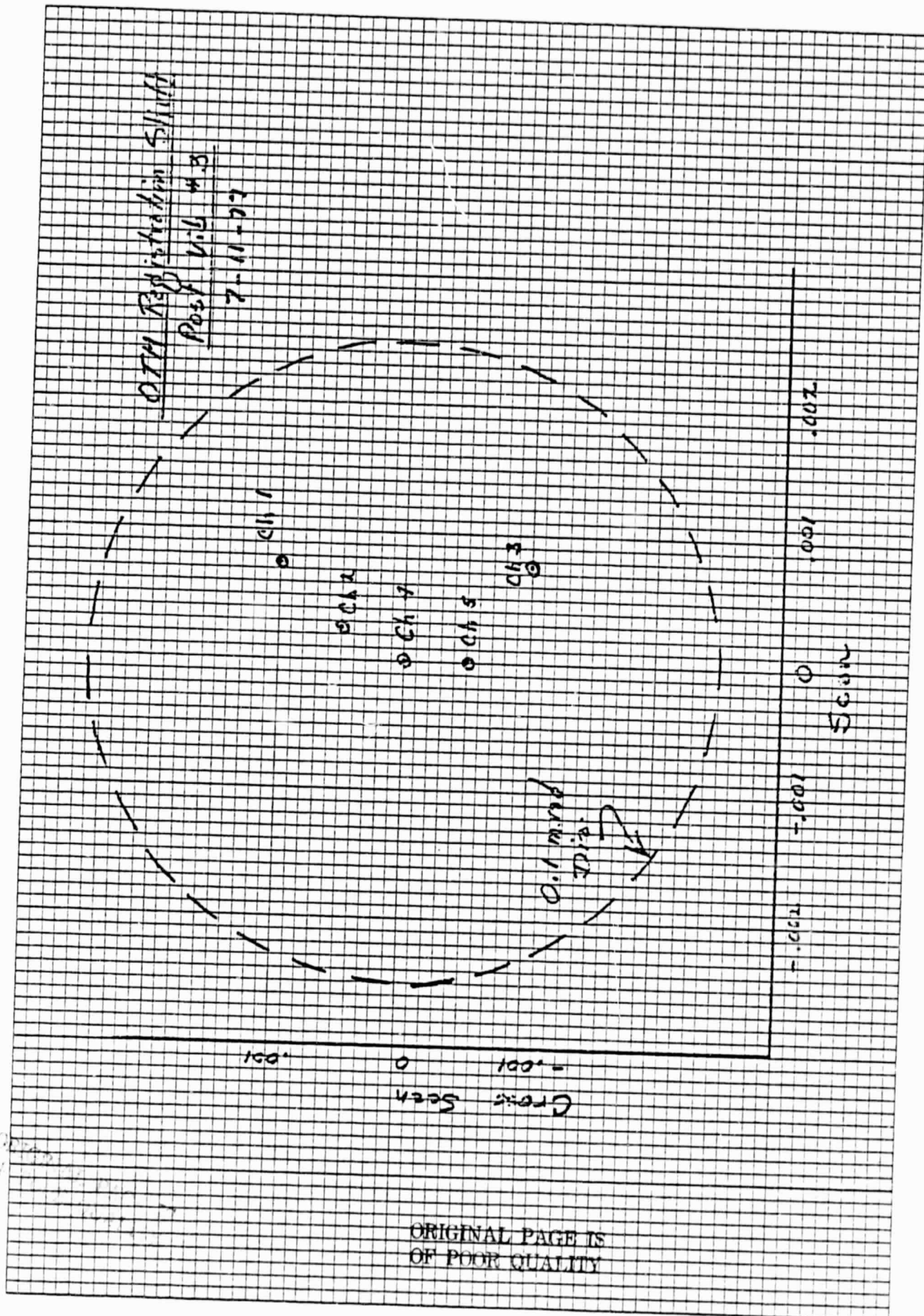


FIGURE 2-1

OTM MECHANICAL TEST HISTORY

1. OTM COOLER - QUAL LEVEL VIBRATION
NO STRUCTURAL FAILURES
2. OTM QUAL LEVEL #1
PATCH DICHROIC BROKE DURING FIRST (Y) AXIS. (MR E03348)
REGISTRATION OF CH 1, 2, AND 4 IN SPEC.
3. OTM QUAL LEVEL #2 AND SINE SURVEYS
REGISTRATION OF CH. 1, 2, AND 4 IN SPEC.
REGISTRATION OF CH. 3 AND 5 SHIFTED 0.3 MRAD. (MR E03349)
MICRO-CRACK IN PATCH DICHROIC (MR E03350)
4. OTM QUAL LEVEL #3
NO DICHROIC DAMAGE.
REGISTRATION OF ALL CHANNELS MAINTAINED



ORIGINAL PAGE IS
OF POOR QUALITY

OPTICS SUBASSEMBLY MTF

Spatial Freq. <u>(cycles</u> <u>radian)</u>	ON AXIS		EFOV EDGE	
	SPEC. (MIN.)	MEASURED	SPEC. (MIN.)	MEASURED

CHANNEL 3

96	N.R.	97.2	N.R.	X
192	N.R.	94.5	N.R.	X
257	90	92.7	90	92.4
385	86	89.0	86	88.0

CHANNEL 4

96	N.R.	96.8	N.R.	X
192	N.R.	93.7	N.R.	X
257	91	91.8	91	91.1
385	88	90.2	88	88.2

CHANNEL 5

96	N.R.	98.3	N.R.	X
192	N.R.	94.7	N.R.	X
257	90	92.6	90	93.5
385	86	88.9	86	89.2

OPTICS SUBASSEMBLY FOV

	<u>On-Axis</u>	<u>Edge of EFOV</u>
Ch. 3	1.36 m.r.	1.34
Ch. 4	1.35	1.37
Ch. 5	1.26	1.24

OTM - INSTRUMENT IFOV MEASUREMENTS

	<u>SCAN</u>	<u>CROSS SCAN</u>
CH. 3	1.25 M.R.	1.28 M.R.
CH. 4	1.22 M.R.	1.22 M.R.
CH. 5	1.24 M.R.	1.31 M.R.

SPEC - $1.31 \pm .2$ M.R.

PARAMETER		SPECIFIED	MEASURED
<u>CHANNEL 3:</u>			
SHORT WVLN.*	50% RESPONSE	$10.3 \pm 0.09 \mu\text{m}$	$10.28 \mu\text{m}$
LONG WVLN.	50% RESPONSE	$11.3 \pm 0.09 \mu\text{m}$	$11.18 \mu\text{m}^*$
CUTON SLOPE,	SHORT WVLN.	$\leq 4.0\%$	2.3%
CUTOFF SLOPE,	LONG WVLN.	$\leq 4.0\%$	3.7%
SHORT WVLN.	1% RESPONSE	$\lambda' s \leq 9.8 \mu\text{m}$	10.0 & BELOW
LONG WVLN	1% RESPONSE	$\lambda' s \geq 11.8 \mu\text{m}$	11.5 & ABOVE
<u>CHANNEL 4:</u>			
SHORT WVLN.	50% RESPONSE	$3.55 \pm 0.06 \mu\text{m}$	$3.55 \mu\text{m}$
LONG WVLN.	50% RESPONSE	$3.93 \pm 0.06 \mu\text{m}$	$3.95 \mu\text{m}$
CUTON SLOPE,	SHORT WVLN	$\leq 3.0\%$	1.9%
CUTOFF SLOPE,	LONG WVLN	$\leq 3.0\%$	1.8%
SHORT WVLN.	1% RESPONSE	$\lambda' s \leq 3.40 \mu\text{m}$	$3.49 \mu\text{m}$ & BELOW
LONG WVLN.	1% RESPONSE	$\lambda' s \geq 4.12 \mu\text{m}$	$4.02 \mu\text{m}$ & ABOVE
<u>CHANNEL 5:</u>			
SHORT WVLN.	50% RESPONSE	$11.5 \pm 0.09 \mu\text{m}$	$11.43 \mu\text{m}$
LONG WVLN.	50% RESPONSE	$12.5 \pm 0.09 \mu\text{m}$	$12.40 \mu\text{m}^{**}$
CUTON SLOPE,	SHORT WVLN.	$\leq 4.0\%$	1.8%
CUTOFF SLOPE,	LONG WVLN	$\leq 4.0\%$	3.0%
SHORT WVLN.	1% RESPONSE	$\lambda' s > 10.9 \mu\text{m}$	$11.2 \mu\text{m}$ & BELOW
LONG WVLN	1% RESPONSE	$\lambda' s \geq 13.1 \mu\text{m}$	$12.6 \mu\text{m}$ & ABOVE

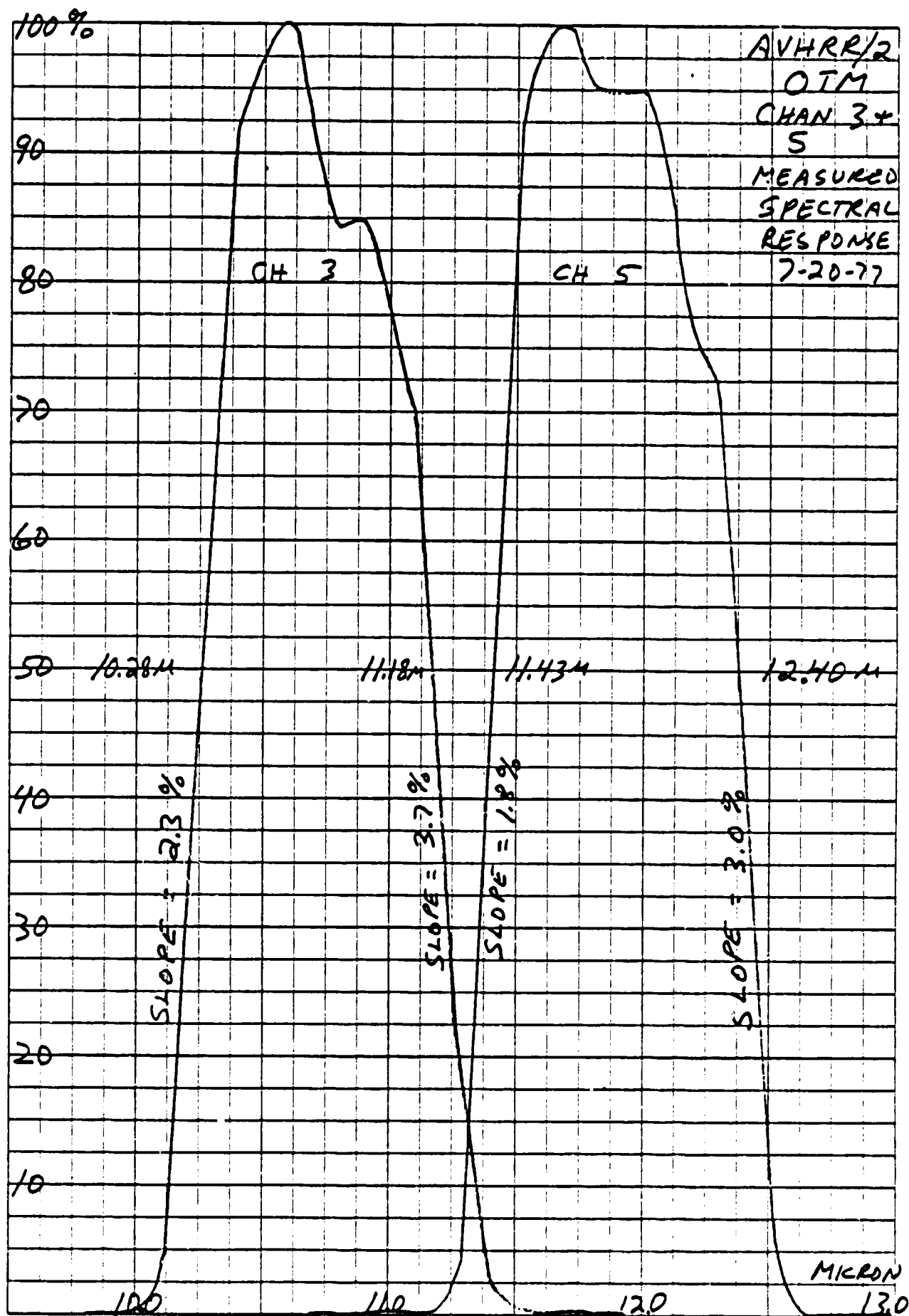
WVLN. = WAVELENGTH *OUT OF SPEC. BY $0.03 \mu\text{m}$

**OUT OF SPEC. BY $0.01 \mu\text{m}$

AVHRR/2, INFRARED SPECTRAL CHARACTERISTICS

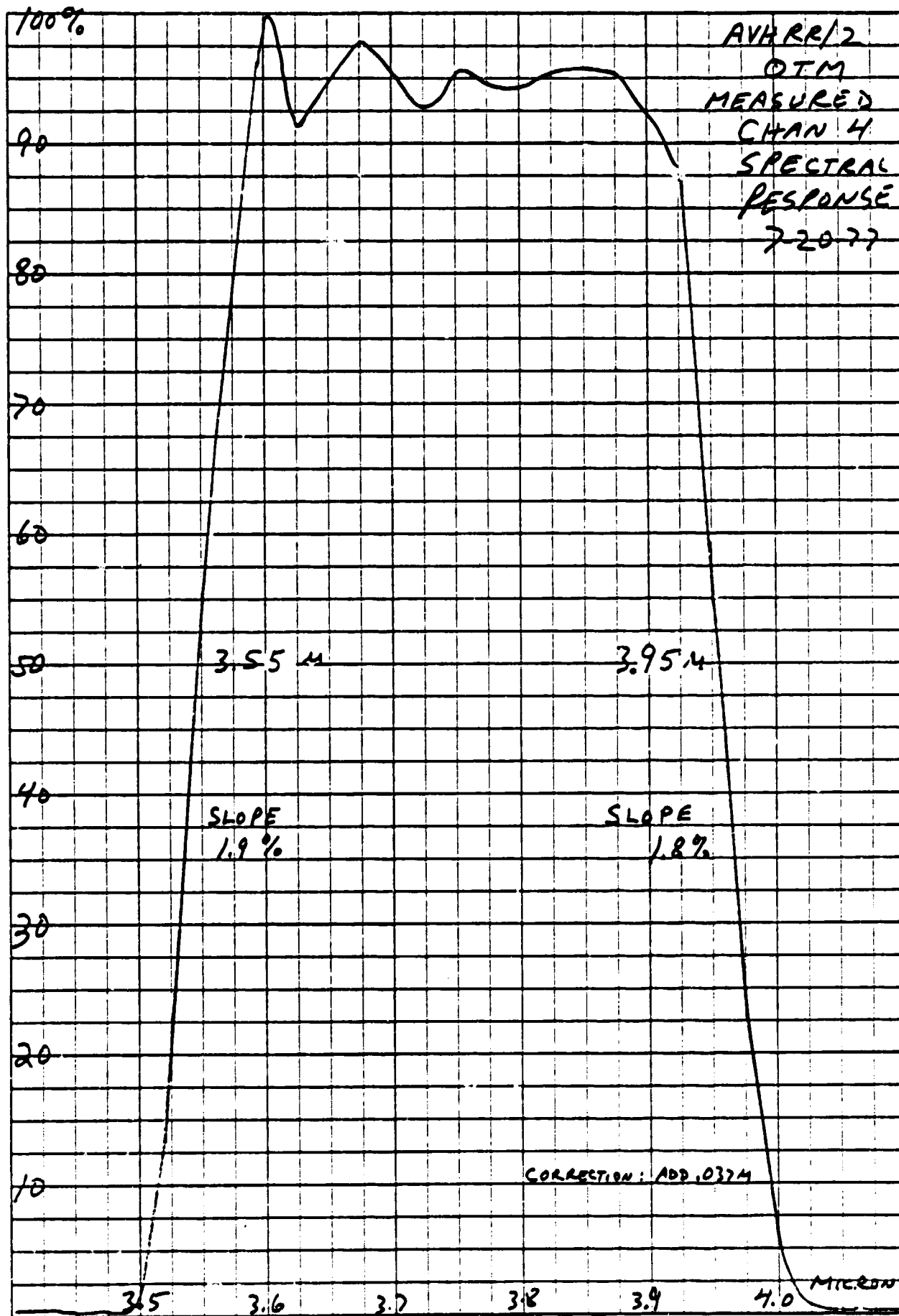
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AVHRR/2 OTM RADIANT COOLER THERMAL PERFORMANCE

	CHAMBER TESTS (A)		ANALYTICAL MODEL PREDICTED
	MEASURED	CORRECTED (B)	
COOLER HOUSING OPTICS (C)	3.3°C 13°C	17.5°C 20°C	17.5°C 20°C
RADIATOR	167.7K, 167.4K	171.0K, 170.7K	168.8K - 171.2K (D)
UNCONTROLLED PATCH	-	96.9K, 97.1K	95.4K - 96.3K
CONTROLLED PATCH	103.4K, 108.3K	105.0K	105.0K
CONTROL POWER	22.04mW, 41.04mW	29.4mW, 28.7mW	34.0mW - 31.3mW
JOULE HEAT	1.46mW	3.5mW	3.5mW

- (A) FEB. 28 - MARCH 2, 1977
- (B) TO NOMINAL ORBIT (833 KM ALTITUDE, 37.5° SUN ANGLE),
INCL. ABSENCE OF SPACE TARGET INPUT.
- (C) EXCEPT FOR CHANNEL 4 INPUT TO RADIATOR, WHICH IS AT
HOUSING TEMPERATURE.
- (D) FOR INSULATION FACTORS IN THE RANGE 65 TO 50.

AVHRR/2 OTM RADIANT COOLER THERMAL PERFORMANCE - POST VIBRATION

	CHAMBER TESTS (A)		ANALYTICAL MODEL PREDICTED
	MEASURED	CORRECTED (B)	
COOLER HOUSING	10.5C	17.5°C	17.5°C
OPTICS (C)	14°C	20°C	20°C
RADIATOR	169.4K	171.4K	168.8K - 171.2K ^(D)
UNCONTROLLED PATCH	- -	98.0K	95.4K - 96.3K
CONTROLLED PATCH	104.1K	105.0K	105.0K
CONTROL POWER	18.8mW	25.9mW	34.0mW - 31.2mW
JOULE HEAT	1.46mW	3.5mW	3.5mW

(A) JULY 20-22, 1977

(B) TO NOMINAL ORBIT (833 KM ALTITUDE, 37.5° SUN ANGLE),
INCL. ABSENCE OF SPACE TARGET INPUT.

(C) EXCEPT FOR CHANNEL 4 INPUT TO RADIATOR, WHICH IS AT
HOUSING TEMPERATURE.

(D) FOR INSULATION FACTORS IN THE RANGE 65 TO 50.

AVHRR/2

RESUME OF PFM TEST RESULTS

ITEM	SPECIFICATION	MEASURED												
SIZE	MAX. 30.75" x 11.5" x 14.5"	30.25" x 11.19" x 14.31" EXCLUDING THERMAL BLANKET												
WEIGHT	65 LB.	63.31 LBS. WITH THERMAL BLANKET												
POWER	28.5 WATTS	26.13 WATTS												
CENTER OF GRAVITY	--	<table border="0"> <thead> <tr> <th></th> <th><u>DOOR OPEN</u></th> <th><u>DOOR CLOSED</u></th> </tr> </thead> <tbody> <tr> <td>X</td> <td>4.93"</td> <td>4.86"</td> </tr> <tr> <td>Y</td> <td>12.34"</td> <td>12.34"</td> </tr> <tr> <td>Z</td> <td>1.20"</td> <td>1.28"</td> </tr> </tbody> </table>		<u>DOOR OPEN</u>	<u>DOOR CLOSED</u>	X	4.93"	4.86"	Y	12.34"	12.34"	Z	1.20"	1.28"
	<u>DOOR OPEN</u>	<u>DOOR CLOSED</u>												
X	4.93"	4.86"												
Y	12.34"	12.34"												
Z	1.20"	1.28"												
VIBRATION	SEE SPEC. PARA. 4.4.4.3	PASSED EXCEPT FOR MR E03437 AND MR E03438												
SCAN PLAN ALIGNMENT	MAX. CHANGE 0.5 MRAD AFTER VIBRATION	<table border="0"> <thead> <tr> <th></th> <th><u>BEFORE</u></th> <th><u>AFTER</u></th> <th><u>CHANGE</u></th> </tr> </thead> <tbody> <tr> <td>NADIR</td> <td>+ .04</td> <td>-.44</td> <td>.48</td> </tr> <tr> <td>90°</td> <td>-.86</td> <td>-.76</td> <td>.10</td> </tr> </tbody> </table>		<u>BEFORE</u>	<u>AFTER</u>	<u>CHANGE</u>	NADIR	+ .04	-.44	.48	90°	-.86	-.76	.10
	<u>BEFORE</u>	<u>AFTER</u>	<u>CHANGE</u>											
NADIR	+ .04	-.44	.48											
90°	-.86	-.76	.10											
CHANNEL REGISTRATION	ALL IFOV CENTERS WITHIN 0.1 MRAD.	<table border="0"> <tbody> <tr> <td>INITIALLY</td> <td>0.08 MRAD.</td> </tr> <tr> <td>AFTER VIB.</td> <td>0.05 MRAD.</td> </tr> </tbody> </table>	INITIALLY	0.08 MRAD.	AFTER VIB.	0.05 MRAD.								
INITIALLY	0.08 MRAD.													
AFTER VIB.	0.05 MRAD.													

<u>ITEM</u>	<u>SPECIFICATION</u>	<u>MEASURED</u>
SCAN JITTER	LINE-TO-LINE, 98% WITHIN $\pm 17 \mu\text{SEC}$ SCENE, 98% WITHIN $\pm 27 \mu\text{SEC}$ LONG TERM P-P, $34 \mu\text{SEC}$ MAX.	$> 98\%$, $\pm 16 \mu\text{SEC}$. $> 98\%$, $\pm 16 \mu\text{SEC}$ IN SCAN 100% $\pm 16 \mu\text{SEC}$ IN X SCAN $< 34 \mu\text{SEC}$.
IFOV SIZE AT 50% POINTS	1.3 ± 0.2 MRAD.	CH 1: 1.44×1.43 CH 2: 1.43×1.42 CH 3: 1.28×1.46 CH 4: 1.42×1.42 CH 5: 1.32×1.31
SYSTEM MTF	$> 30\%$ AT IFOV FREQUENCY	CH 1: 44% CH 2: 45% CH 3: 42% CH 4: 49% CH 5: 37%
CH 1 & 2 SPECTRAL RESPONSE	SEE PARA. 3.4.2 OF SPEC	CH 1: IN SPEC. CH 2: IN SPEC. (SEE APPENDIX)
CH 1 & 2 SIGNAL STABILITY	CH 1 ± 100 MV, CH 2 ± 120 MV OVER 10^0 TO 30°C RANGE	CH 1: 40 MV TOTAL CH 2: 82 MV TOTAL

<u>ITEM</u>	<u>SPECIFICATION</u>	<u>MEASURED</u>
CH 1 & 2 S/N RATIO	3/1 @ 0.5% ALBEDO (=10 MV NOISE)	CH 1: 2.96 MV.) S/N = 10/1 @ 0.5% CH 2: 2.99 MV.) ALBEDO
CH 3, 4, & 5 SPECTRAL RESPONSE	SEE PARA. 3.4.2 OF SPEC	CH 3: LONG WAVE SLOPE OUT OF SPEC. (MR E03431) CH 4 & CH 5: IN SPEC (SEE APPENDIX)
CH 3, 4, & 5 SIGNAL STABILITY	CH 3 & 5 \pm 100 MV, 10°C TO 21°C CH 4 \pm 100 MV, 10°C TO 30°C	CH 3: 172 MV CH 5: 49 MV CH 4: 216 MV (MR F04271)
CH 3, 4, & 5 NE/T (108K PATCH TEMP)	CH 3 & 4 0.12K CH 5 0.13K	CH 3: .052K CH 4: .056K CH 5: .046K
SIGNAL AMPLITUDE CH 1 & 2	100% ALBEDO = 6.1 ± 0.1 V SPACE CLAMP = $0.25 \pm .05$ V	CH 1: 4.8416 @ 79.1% ALBEDO = 6.12 V @ 100% CH 2: 5.658 @ 93.13% ALBEDO = 6.08 V @ 100% CH 1: 0.237 V CH 2: 0.247 V

ITEM	SPECIFICATION	MEASURED		
		Ch 3	Ch 4	Ch 5
SIGNAL AMPLITUDE	320K \pm 1K = 0.3 ± 0.1 V	@ 320K 0.1377	0.1158	0.2137
Ch 3, 4, & 5	(15° BASELINE)	@ 319K 0.2113	0.3239	0.2830
		(CALCULATED)		
	SPACE CLAMP = 6.2 ± 0.05 V	6.201	6.210	6.195
COMMAND OPERATION		OPERATION AND DIGITAL TM LEVEL VERIFIED.		
ANALOG TM		INSTRUMENT STATUS MEASURED		
TURN ON TRANSIENT (28V)				
ELECTRONICS	1.4A MAX. @ 20 MA/ μ SEC	540 MA - 2.2 MA/ μ SEC.		
MOTOR	1.4A MAX. @ 20 MA/ μ SEC	500 MA - 0.3 MA/ μ SEC.		
COOLER HEAT	3.3A MAX. FOR 2 M.S.	2.3A FOR 500 μ SEC.		
EARTH SHIELD	2.1A MAX. FOR 1 SEC	1.8A FOR .65 SEC		
CONDUCTED RIPPLE (28V)	< 20 Hz	> 20 Hz		
MOTOR - LOW	27 MA MAX.	< 5 MA	< 5 MA	
MOTOR - HIGH		< 5 MA	< 5 MA	
ELECT. & ALL CH'S		14 MA	< 5 MA	
FULL INST.		8 MA	< 5 MA	
SUSCEPTIBILITY	.25V P-P TO 1.5 KHZ .50V P-P TO 10 MHK	WORST CASE 1.5 V @ 20 KHZ.		

SPECIFICATION

MEASURED

ITEM

CONDUCTED RIPPLE (+10V) 2 MA MAX.
 CONDUCTED RIPPLE (+5V) 1 MA MAX.

AMPLIFIER DROOP .39% OF FULL SCALE
 (25 MV)
 .098% FULL SCALE
 (6 MV) DESIGN GOAL

CH 1 .1 MV
 CH 2 1.3 MV
 CH 3 .08 MV
 CH 4 .15 MV
 CH 5 .26 MV

VERIFICATION OF TM IN DATA STREAM
 DIFFERENCE
 ± 12.5 M.V. MAX.

	IM	DATA	Δ
BB1	1.192 V	1.185V	7MV
BB2	1.208 V	1.2003V	7.7MV
BB3	1.207V	1.2003V	6.7MV
BB4	1.267V	1.2609V	6.1MV
PATCH TEMP	2.911V	2.906V	5 MV

BB SAMPLE TM
 DIFFERENCE
 ±12.5 MV. MAX.

	IM	DATA	Δ
CH 3	2483	2481	2 MV
CH 4	No DATA	TEST EQUIP PROBLEM	
CH 5	2373	2365	8 MV

VOLTAGE CAL
 VERIFICATION
 3 EARTH SCENE LEVELS
 1 B.B. LEVEL

	IM	DATA	Δ
CH 1	1832	3468	5093
CH 2	1856	3481	5100
CH 3	1331	2950	4570
CH 4	1337	2962	4594
CH 5	1349	2968	4587

DETECTOR DISABLED

VERIFIED DET. DIS.

ITEM	SPECIFICATION	MEASURED
OVER-VOLTAGE	28V TO 39V	± 15 V REGULATED VOLTAGES VARY 3 MV - +5 V SUPPLY VARIES 32 MV.
AMPLIFIER ZEROING	CH 1 .250 \pm 0.050 V CH 2 .250 \pm 0.050 V CH 3 6.2 \pm 0.50 V CH 4 6.2 \pm 0.50 V CH 5 6.2 \pm 0.50 V	225 MV 238 MV 6201 MV 6211 MV 6194 MV
AMPLIFIER LINEARITY	\pm 12.5 MV MAX	CH 1 - 4 MV MEASURED WITH CH 2 - 2 MV RAMP CAL AND CH 3 - 6 MV DATA CONVERTER CH 4 - 4.7 MV CH 5 - 1.3 MV
RAMP CAL RANGE	0.025 TO + 6.475	CH 1 3247 CH 2 3245 CH 3 3238 CH 4 3276 CH 5 3242 (HALF AMPLITUDE MEASUREMENTS. MULTIPLY BY 2 FOR FULL RANGE)
AUXILIARY SCAN	NONE	SYNC PULSE TO COLLIMATOR TARGET VERIFIED OPERATION

AVHRR/2 PFM

CALIBRATION EQUATIONS

RADIATOR TEMP	°K	=	32.584 V	+	141.692	+	.452V ²
PATCH POWER	MW	=	2V ²				
PATCH TEMP LOW RANGE	°K	=	4.997 V	+	90.005	+	.0297 V ²
PATCH TEMP EX RANGE	°K	=	34.826 V	+	90.769	+	2.074 V ²
BB#1 TM	°C	=	.0349 V ²	+	8.204 V	+	3.437
BB#2 TM	°C	=	.0349 V ²	+	8.204 V	+	3.437
BB#3 TM	°C	=	.0349 V ²	+	8.204 V	+	3.437
BB#4 TM	°C	=	.0349 V ²	+	8.204 V	+	3.437
MOTOR CURRENT	MA	=	60V				
ELECTRONICS CURRENT	MA	=	196.5 V				
EARTH SHIELD POSITION		=	<2V - CL		2-4 - MID		>4V - OPEN
ELECTRONICS TEMP	°C	=	-5.82V	+	39.9		
BASE PLATE TEMP	°C	=	-7.75V	+	34.8		
A TO D TEMP	°C	=	-8.33V	+	86.16		
MOTOR HOUSING TEMP	°C	=	-7.75V	+	34.8		
COOLER HOUSING TEMP	°C	=	-7.75V	+	34.8		
DETECTOR BIAS VOLTS		=	4.33V	-	21.33		
BB IR CH 3	°C	=	49.37	-	14.839 V	+	.8329 V ² -
					.4582 V ³	+	.03498 V ⁴
BB IR CH 4	°C	=	19.85	+	28.696 V	-	15.116 V ² +
					2.939 V ³	-	.23074 V ⁴
BB IR CH 5		=	44.3544	-	2.397 V	-	9.581 V ² +
OFFSET VOLTAGE	TM	=	1.33 V	-	.37407 V ⁴		

AVHRR/2
TEST DATA
APPENDIX

ITT AEROSPACE/OPTICAL DIVISION
 FORT WAYNE, INDIANA, U.S.A.
 TELEPHONE 317-491-1111

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AVIAR S.N. 201/1PFM

DATE 3/20/78 Q.C.

ENGINEER D. HARDEN & L. OWERS

	CHANNEL 1		CHANNEL 2	
	SPEC.	MEASURED	SPEC.	MEASURED
SHORT WAVE 80% WV'LN.	WITHIN 0.04 μ M OF 50% WV'LN.	.04 μ M	WITHIN 0.02 μ M OF 50% WV'LN.	.0093 μ M
SHORT WAVE 50% WV'LN.	0.58 \pm 0.04 μ M	.57 μ M	0.725 \pm .025 μ M	712.7 μ M
SHORT WAVE 5% WV'LN.	WITHIN 0.14 μ M OF 50% WV'LN. ***	.016 μ M	WITHIN 0.04 μ M OF 50% WV'LN. *	.0137 μ M
LONG WAVE 80% WV'LN.	WITHIN 0.02 μ M OF 50% WV'LN.	.009 μ M	WITHIN 0.2 μ M OF 50% WV'LN.	.0599 μ M
LONG WAVE 50% WV'LN.	0.68 \pm 0.04 μ M	.6859 μ M	1.00 \pm 0.05 μ M	.9859 μ M
LONG WAVE 5% WV'LN.	WITHIN 0.04 μ M OF 50% WV'LN.	.031 μ M	WITHIN 0.06 μ M 50% WV'LN	.0921 μ M
RESPONSE BETWEEN S.W. 80% WV'LN. AND L.W. 80% WV'LN.	80% MIN.	> 80%	80% MIN.	> 80%

ORIGINAL PAGE IS
 OF POOR QUALITY

N.R. = NO REQUIREMENT

* S.W. 5% WV'LN. OF CHANNEL 2 MUST ALWAYS EXCEED 0.685 μ M

** MINIMUM Δ BETWEEN 50% POINTS SHALL BE 0.10 μ M.

*** S.W. 5% WV'LN. OF CH. 1 MUST BE GREATER THAN 0.46 μ M

TABLE 5

CHANNEL 1 & 2 SPECTRAL CHARACTERISTICS

DWG CODE IDENT NO.

A 31550

SIZE

SCALE

8125979

SHEET 10

ITT AEROSPACE/OPTICAL DIVISION
FORT WAYNE, INDIANA, U.S.A.
INTEGRATIONAL TESTS AND TELESCOPE CORP.

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DRAWING NUMBER
8125979

REV
A

AVIRR S.N. 201 / PFM

ENGINEER

D. HARDER L. OWENS

DATE 3/28/78

Q.C.

	CHANNEL 3		CHANNEL 4	
	SPEC.	MEASURED	SPEC.	MEASURED
SHORT WAVE 50% WV'LN.	10.3 ± 0.09 μm	10.362 μm	3.55 ± 0.06 μm	3.575 μm
S.W. 80% OF 1ST PEAK WV'LN.	SEE S.W. SLOPE	10.410 μm	SEE S.W. SLOPE	3.592 μm
S.W. 5% WV'LN.	SEE S.W. SLOPE	10.230 μm	SEE S.W. SLOPE	3.528 μm
S.W. SLOPE*	<4.0%	1.7%	<3.0%	1.8%
LONG WAVE 50% WV'LN.	11.3 ± 0.09 μm	11.299 μm	3.93 ± 0.06 μm	3.983 μm
L.W. 80% OF 1ST PEAK WV'LN.	SEE L.W. SLOPE	10.995 μm	SEE L.W. SLOPE	3.961 μm
L.W. 5% WV'LN.	SEE L.W. SLOPE	11.470 μm	SEE L.W. SLOPE	4.032 μm
L.W. SLOPE*	<4.0%	4.1%	<3.0%	1.8%
RESPONSE BETWEEN S.W. 80% WV'LN. & L.W. 80% WV'LN.	80% MIN.	780%	80% MIN.	780%
RESPONSE AT WV'LN. <10.0 μm AND >12.0 μm	<1%	DID NOT MEAS. OUT OF BAND	N/A	N/A
RESPONSE AT WV'LN. <3.40 μm AND >4.12 μm	N/A	N/A	<1%	DID NOT MEAS. OUT OF BAND

*SLOPE = [(80% OF FIRST PEAK WV'LN. - 5% WV'LN.) ÷ 50% WV'LN.] x 100%

TABLE 6
CHANNELS 3 AND 4 SPECTRAL CHARACTERISTICS

DWG
A
SIZE
CODE IDENT NO.
31550

8125979

SCALE

SHEET 11

ITT AEROSPACE/OPTICAL DIVISION
FORT WAYNE, INDIANA, U.S.A.
INTERNATIONAL TELEPHONE AND TELEGRAPH COOPERATION

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REV
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AVIRR S.M. 201 / PFM DATE 3/28/78 Q.C.

ENGINEER D. HARDER & OWENS

DWG
A
SIZE
SCALE

CODE IDENT NO.
31550

8125979

SHEET 12

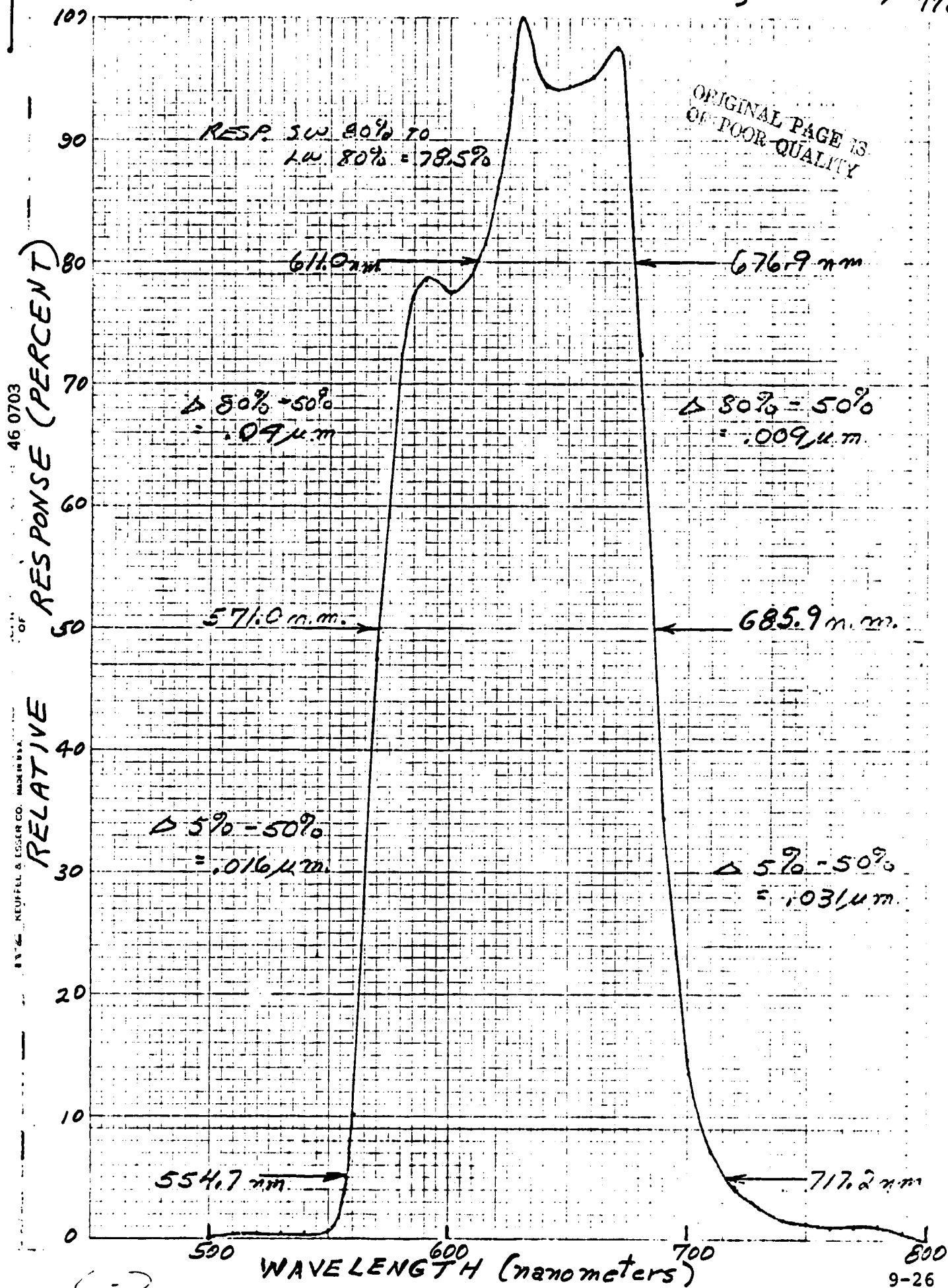
CHANNEL 5	
SPEC.	MEASURED
SHORT WAVE 50% WV'LN.	11.5 ± 0.09 μm
S.W. 80% OF 1ST PEAK WV'LN.	11.500 μm
S.W. 5% WV'LN.	11.245 μm
S.W. SLOPE*	2.3%
LONG WAVE 50% WV'LN.	12.5 ± 0.09 μm
L.W. 80% OF 1ST PEAK WV'LN.	12.145 μm
L.W. 5% WV'LN.	12.545 μm
L.W. SLOPE*	3.2%
RESPONSE BETWEEN S.W. 80% WV'LN. & L.W. 80% WV'LN.	> 80%
RESPONSE AT WV'LN. < 10.0 μm AND > 12.0 μm	0.0 NOT MEAS OUT OF BAND

*SLOPE = $\left[(80\% \text{ OF FIRST PEAK WV'LN.} - 5\% \text{ WV'LN.}) \div 50\% \text{ WV'LN.} \right] \times 100\%$

TABLE 7
CHANNEL 5 SPECTRAL CHARACTERISTICS

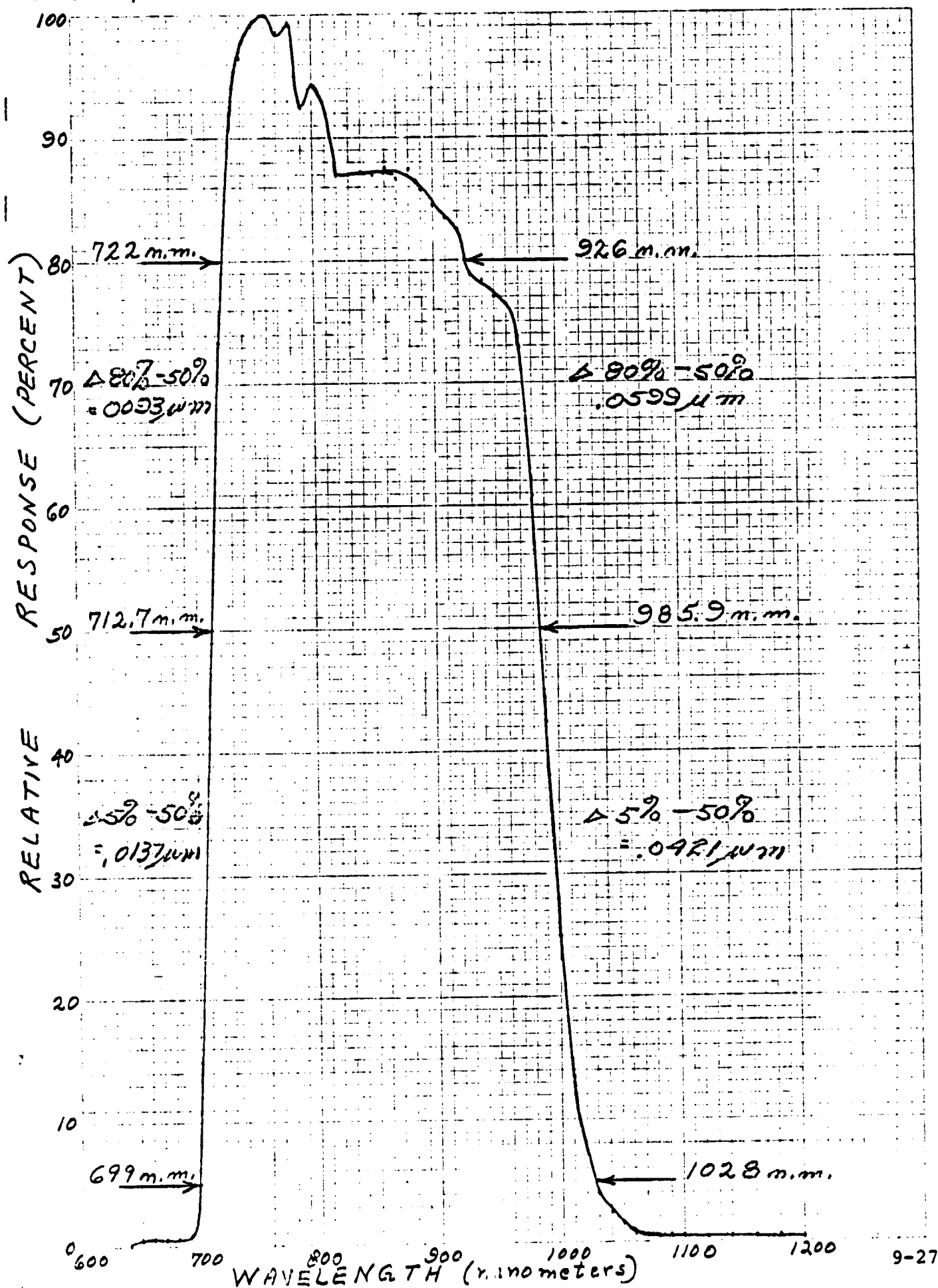
AVHRR/2 PFM SPECTRAL RESPONSE, CH. 1

3/28/78



AVHRR/2 PFM SPECTRAL RESPONSE, CH. 2

3/28/78



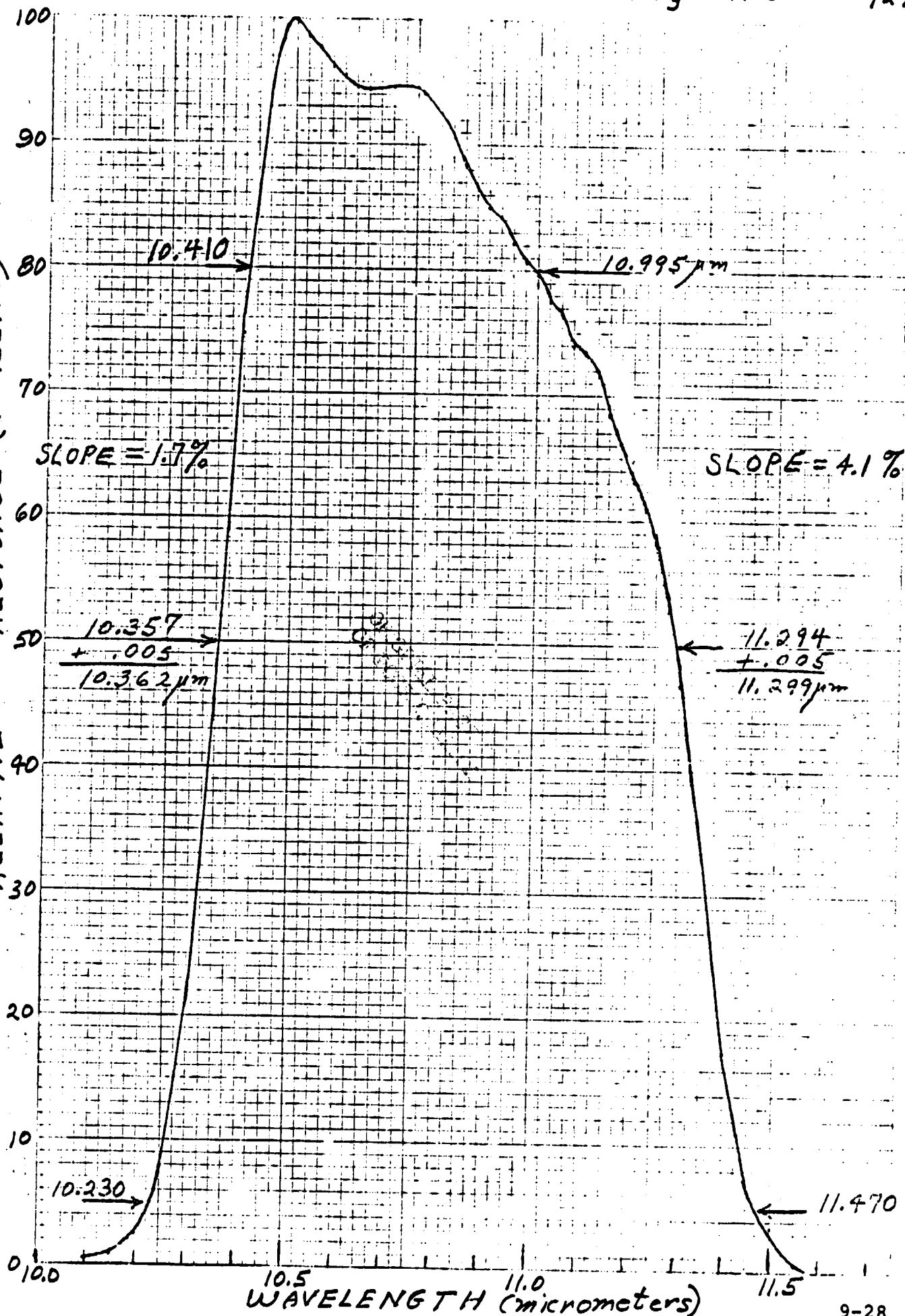
AVHRR/2 PFM SPECTRAL RESPONSE, CH. 3

3/27/76

10 X 10 TO THE INCH • 7 X 10 INCHES
NEUFEL & ESSER CO. MADE IN U.S.A.

46 0703

RELATIVE RESPONSE (PERCENT)

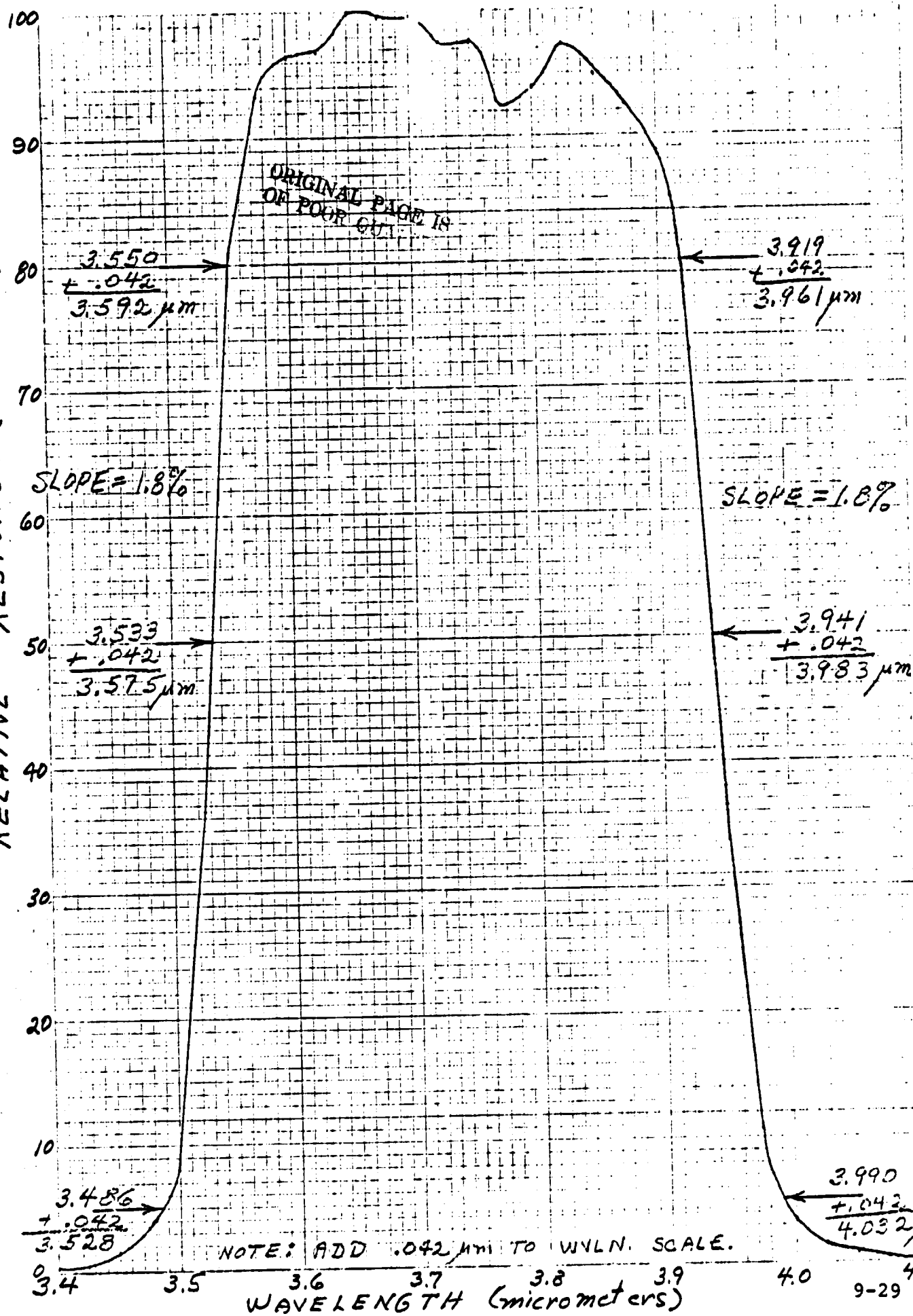


AVHRR/2 P.F.M. SPECTRAL RESPONSE, CH. 4

3/27/78

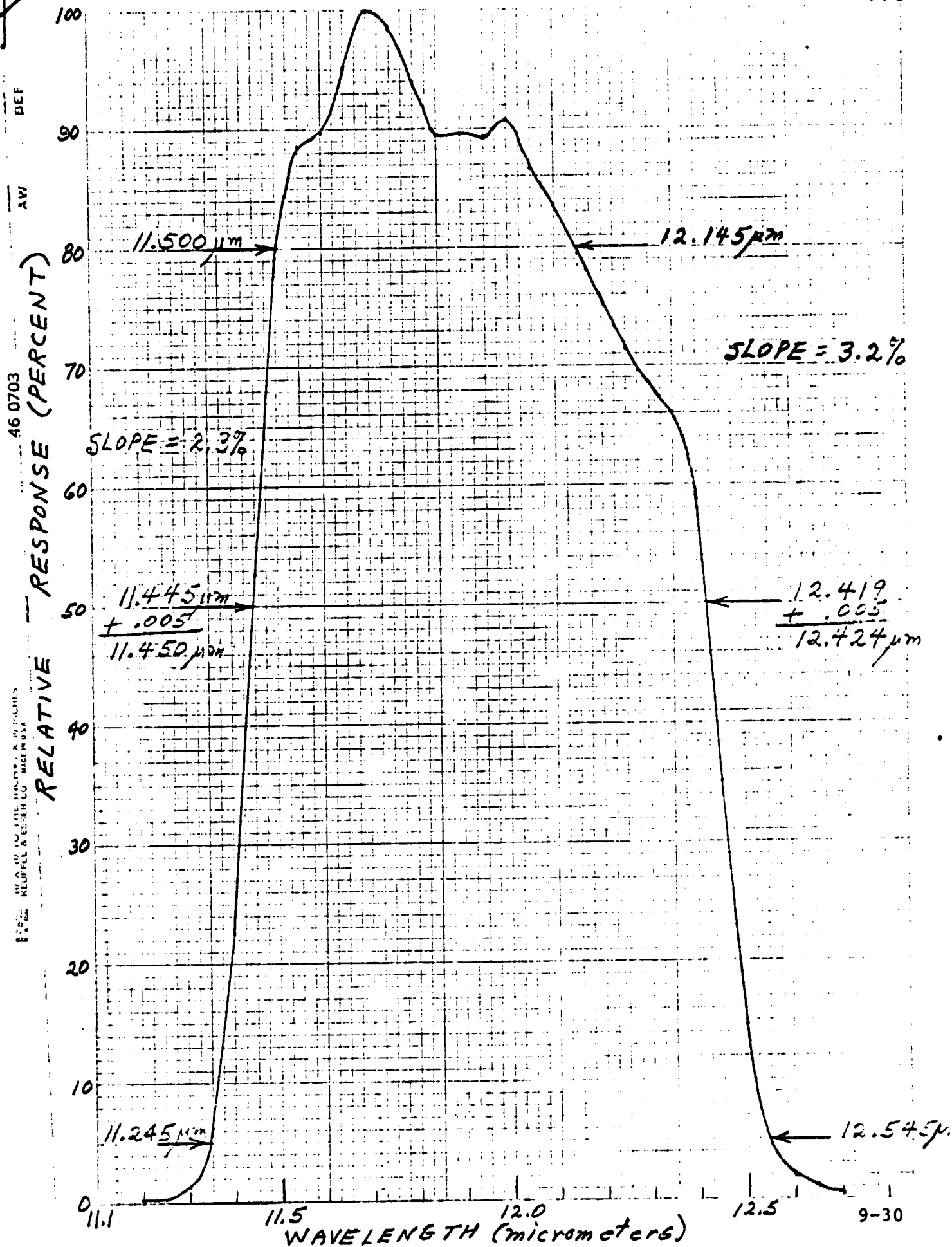
46 0703
RELATIVE RESPONSE (PERCENT)

10 X 10 TO THE INCH = 7 X 10 INCHES
KLUFFEL & LUSHER CO. AND #93



AVHRR/2 PFM SPECTRAL RESPONSE, CH. 5

3/28/78



10.0 LIST OF DESIGN INFORMATION REPORTS

Design Information Reports written on the AVHRR programs are listed below.

<u>DIR #</u>	<u>Subject</u>
1.	AVHRR Sensitivity - Harber/Koczor
2.	AVHRR Collimator - Diffraction Effects - R. Koczor
3.	Effects of Optical Surface Errors on Diffraction Limited MTF - R. Annable
4.	Approach to the Optical Alignment and Channel Registration of the AVHRR - R. Annable
5.	The Effect of Detectors on the Instrument Spectral Response, Part 1, Channels 3 & 4 - R. Koczor
6.	Theoretical Design to Meet the Polarization Requirements in Channels 1 and 2 - R. Annable
7.	Polarization Design and Analysis Based on OCLI Measured Data - R. Annable
8.	Using "Standard" Silicon Detectors for Channels 1 and 2 - R. Koczor
9.	Effect of Scan Mirror Power on Diffraction Limited MTF - R. Annable
10.	Visible In-Flight Calibration - R. Koczor
11.	Orientation of the Visible Calibration D.R.T. - R. Koczor
12.	Solar Channel Spectral Characteristics, Part 1 - R. Koczor
13.	Solar Channel Sensitivity - R. Koczor
14.	The Absence of Coma in an Afocal Pair of Confocal, Coaxial Parabolic Mirrors - R. Annable
15.	Heating of the Radiator Window for Contamination Protection - R. Annable
16.	AVHRR Test Collimator Design - R. Koczor
17.	The Effect of Collimator Aberrations on the Diffraction Limited MTF - R. Annable
18.	Worst Case Honeycomb Temperature Gradient in the In-Flight Thermal Calibration Target - R. Annable
19.	Cool Down and Decontamination Times for the Radiant Cooler - R. Annable
20.	Scanner Jitter, Linearity, and Alignment Tests - R. Koczor
21.	Optimization of IFOV Size and Shape, Pre-Sampling Filter, and Sample Rate - R. Foote
22.	Thermal Math Model Analysis - Crawford/Wright
23.	Thermal Math Model Analysis, OFF Instrument - Crawford/Wright
24.	Measurement of Low Emissivity - R. Koczor

DIR #Subject

25.	AVHRR Scan Motor Lubricant Evaluation and Selection - J. Stark
26.	AVHRR TM Calibration - N. Franklin
27.	MSM Vibration Test - J. Stark
28.	BBM Acceptance Test Results - Owens/Koczor
29.	Completion of Thermal Math Model - J. Crawford
30.	MSM Vibration #2 - J. Stark
31.	Effect of Loss of Radiant Cooler Temperature Regulation - R. Harber
32.	Worst Case Analysis - L. Roffelsen
33.	AVHRR MSM Vibration #3 - J. Stark
34.	Spectral Response Measurements on AVHRR ETM - R. Harber
35.	Pinning of Critical Parts - C. Soest
36.	Cooler Door Momentum - C. Soest
37.	Scattered Light Test Results of AVHRR BBM - R. Koczor
38.	Final Thermal Model Analysis - J. Crawford
40.	LTM Final Report - C. Soest
42.	AVHRR Data Amplifier Signal Droop - H. Kalina
43.	Channel 4 Coherent Noise in AVHRR PFM - R. Foote
44.	AVHRR Scanner Long Term Drift Measurement-Larry Howell